HP ProLiant ML570 Generation 2 Server Maintenance and Service Guide



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About This Guide

This maintenance and service guide can be used for reference when servicing an HP ProLiant ML570 Generation 2 Server.



Audience Assumptions

This guide is for service technicians. HP assumes you are qualified in the servicing of computer equipment and trained in recognizing hazard in products with hazardous energy levels and are familiar with weight and stability precautions for rack installations.

Technician Notes



WARNING: Only authorized technicians trained by HP should attempt to repair this equipment. All troubleshooting and repair procedures are detailed to allow only subassembly/module-level repair. Because of the complexity of the individual boards and subassemblies, no one should attempt to make repairs at the component level or to make modifications to any printed wiring board. Improper repairs can create a safety hazard.



WARNING: To reduce the risk of personal injury from electric shock and hazardous energy levels, do not exceed the level of repairs specified in these procedures. Because of the complexity of the individual boards and subassemblies, do not attempt to make repairs at the component level or to make modifications to any printed wiring board. Improper repairs can create conditions that are hazardous.



- WARNING: To reduce the risk of electric shock or damage to the equipment:
- Disconnect power from the system by unplugging all power cords from the power supplies.
- Do not disable the power cord grounding plug. The grounding plug is an important safety feature.
- Plug the power cord into a grounded (earthed) electrical outlet that is easily accessible at all times.

CAUTION: To properly ventilate the system, you must provide at least 7.6 cm (3.0 in) of clearance at the front and back of the server.

CAUTION: The computer is designed to be electrically grounded (earthed). To ensure proper operation, plug the AC power cord into a properly grounded AC outlet only.

NOTE: Any indications of component replacement or printed wiring board modifications may void any warranty.

Where to Go for Additional Help

In addition to this guide, the following information sources are available:

- HP ProLiant ML570 Generation 2 Server Setup and Installation Guide
- Service Quick Reference Guide
- Service training guides
- Service advisories and bulletins
- QuickFind information services
- Insight Manager software
- HP Servers Troubleshooting Guide

Integrated Management Log

The server includes an integrated, nonvolatile management log that contains fault and management information. The contents of the Integrated Management Log (IML) can be viewed with Insight Manager.

Telephone Numbers

For the name of the nearest HP authorized reseller:

- In the United States, call 1-800-345-1518.
- In Canada, call 1-800-263-5868.

For HP technical support:

- In the United States and Canada, call 1-800-652-6672.
- Outside the United States and Canada, refer to www.hp.com

1 Illustrated Parts Catalog

This chapter provides the illustrated parts breakdown and spare parts lists for the HP ProLiant ML570 Generation 2 server. Refer to Table 1-1, Table 1-2, and Table 1-3 for the names of referenced spare parts.

Chassis Components Exploded View



Figure 1-1: Exploded view of the ProLiant ML570 Generation 2 server chassis components

Chassis Components Spare Parts List

Item	Description	Spare Part Number
1	Locking casters	296227-001
2	Blanks kit	253071-001
	a) Removable media bay blank	
	b) Power supply blank	
3	Tower cover kit	309619-001
	a) Access panel	
	Hood labels*	
	b) Tower cover	
	c) Front bezel door	
4	Rack bezel kit	249150-001
	Rack bezel	
	Handles*	
5	Hard drive blank	122759-001
*Not shown		

Table 1-1: Chassis Components Spare Parts List

System Components Exploded View



Figure 1-2: Exploded view of the ProLiant ML570 Generation 2 server system components

System Components Spare Parts List

Table 1-2: System Components Spare Parts List

ltem	Description	Spare Part Number	
1	Power supply, hot-plug 600-W	231782-001	
2	Redundant drive fans, hot-plug 92 mm (3.6 in)	161657-001	
	Drive fan power cable bracket*	249147-001	
3	Drive fan air baffle	178195-001	
4	Processor and I/O fans, hot-plug 127 mm (5 in)	122225-001	
5	Fan basket	161658-001	
	Backplanes		
6	SCSI backplane	263035-001	
7	Power backplane	233962-001	
	Mass Storage Devices		
8	IDE CD-ROM drive (48X)	288894-001	
9	Diskette drive	233409-001	
10	Fan bracket kit	159321-001	
	a) Processor fan bracket		
	b) I/O fan bracket		
*Not sh	*Not shown		

System Tray Components Exploded View



Figure 1-3: Exploded view of the ProLiant ML570 Generation 2 server system tray components

System Tray Components Spare Parts List

Item	Description	Spare Part Number
	Boards	
1	Memory board	285947-001
2	PCI-X backplane	233961-001
	System components	
3	Processor power module (PPM)	266655-001
4	Processor, 1.4-GHz Intel® Xeon MP	272935-001
	Processor, 1.5-GHz Xeon MP*	309617-001
	Processor, 1.9-GHz Xeon MP*	311277-001
	Processor, 2.0-GHz/1M Xeon MP*	327839-001
	Processor, 2.0-GHz/2M Xeon MP*	309618-001
	Processor, 2.5-GHz Xeon MP*	327840-001
	Processor, 2.8-GHz Xeon MP*	327841-001
	Memory (DIMMs)	
5	256-MB PC1600, DDR, ECC, SDRAM DIMM	249674-001
	512-MB PC1600, DDR, ECC, SDRAM DIMM*	249675-001
	1-GB PC1600, DDR, ECC, SDRAM DIMM*	249676-001
	2-GB PC1600, DDR, ECC, SDRAM DIMM*	265791-001
6	System board kit	233958-001
	a) System board	
	b) System tray	
	c) Processor retaining bracket	
7	Rear processor air baffle with fan	278405-001
8	PCI-X Hot-plug basket and processor baffle	307383-001
	a) Front processor air baffle	
	b) Hot-plug expansion board basket	
	Plastics kit*	249746-001
	Expansion slot latch and base, blue	
	Expansion slot latch and base, carbon	
	PCI retaining clip, blue	
	PCI retaining clip, carbon	
	Memory board guide	
	Front bezel retainer	
*Not s	hown	

Table 1-3: System Tray Components Spare Parts List

continued

yboard, carbon* US English	311050 001
US English	211050 001
	311039-001
UK English	311059-031
German	311059-041
French	311059-051
Italian	311059-061
Spanish	311059-071
Danish	311059-081
Norwegian	311059-091
Swedish	311059-101
Canadian French	311059-121
Portuguese	311059-131
Turkish	311059-141
Greek	311059-151
Arab	311059-171
Belgium	311059-181
Hungarian	311059-211
Czech	311059-221
Slovakian	311059-231
Polish	311059-241
Russian	311059-251
Japanese	311059-291
Dutch	311059-331
Finnish	311059-351
International	311059-B31
BHCSY	311059-B41
scellaneous*	
3-V lithium replacement battery	153099-001
Enhanced keyboard, U.S.	244000-001
Mouse, carbon	311060-001
Torx T-15 tool	199630-001
Rack-mounting hardware kit	277921-001
Third-party rack-mounting hardware kit	277922-001
	German French Italian Spanish Danish Danish Norwegian Swedish Canadian French Portuguese Turkish Greek Arab Belgium Hungarian Czech Slovakian Polish Russian Japanese Dutch Finnish International BHCSY scellaneous* 3-V lithium replacement battery Enhanced keyboard, U.S. Mouse, carbon Torx T-15 tool Rack-mounting hardware kit Third-party rack-mounting hardware kit Third-party rack-mounting hardware kit

Table 1-3: System Tray Components Spare Parts List continued

continued

Item	Description	Spare Part Number
	Country kit, U.S. ML570 G2	308702-001
	Return kit, rack (shipping box)	174795-001
	Return kit, tower (shipping box)	265792-001
	Power Cable Kit*	159319-001
	Drive fan cable	158465-001
	CD-ROM/diskette drive cable	158469-001
	SCSI drive cable	158470-001
	LVD cable	158471-001
	Signal Cable Kit*	180305-001
	CD-ROM data cable	158473-002
	34-Pin data cable	158472-002
	Diskette drive data cables	158474-001
	SCSI data cable, 2 drop	157855-001
	ML570 Cable Kit*	249146-001
	SCSI data cable, blue	166298-024
	SCSI data cable, yellow	166298-025
	Internal to external SCSI data cable, 12 inch	232112-001
	PCI to system board data cable	232111-001
	Power backplane cable	232109-001
	Front control panel with cable	225034-002
	Backplane to system board cable	232110-001
	Options*	
	18.2-GB hot-plug Wide-Ultra3 SCSI hard drive with tray (10,000 rpm, 1-inch)	152190-001
	36.4-GB hot-plug Wide-Ultra3 hard drive (15,000 rpm, 1-inch)	233350-001
	18.2-GB hot-plug Wide-Ultra3 hard drive (15,000 rpm, 1-inch)	189395-001
	36.4-GB hot-plug Wide-Ultra3 hard drive (10,000 rpm, 1-inch)	177986-001
	72.8-GB hot-plug Wide-Ultra3 hard drive (10,000 rpm, 1-inch)	233349-001
	DVD drive	217801-001
	Backplane, internal two-bay hot-plug SCSI drive bay	253761-001
	Fan kit, internal two-bay hot-plug SCSI drive bay	253762-001
*Not s	hown	

 Table 1-3: System Tray Components Spare Parts List continued

Removal and Replacement Procedures

This chapter provides subassembly/module-level removal and replacement procedures for HP ProLiant ML570 Generation 2 servers. After completing all necessary removal and replacement procedures, run the Diagnostics program to be sure that all components operate properly.

You need the following items for some procedures:

- Torx T-15 tool
- Torx T-10 tool
- Diagnostics Utility from the SmartStart CD
- Wrist strap

Safety Considerations

Before performing service procedures, review the following safety information.

Electrostatic Discharge

A discharge of static electricity can damage static-sensitive devices or microcircuitry. Proper packaging and grounding techniques are necessary precautions to prevent damage. To prevent electrostatic damage:

- Transport products in static-safe containers such as conductive tubes, bags, or boxes.
- Keep electrostatic-sensitive parts in their containers until they arrive at static-free stations.
- Cover workstations with approved static-dissipating material. Use a wrist strap connected to the work surface and properly grounded (earthed) tools and equipment.
- Keep work area free of nonconductive materials such as ordinary plastic assembly aids and foam packing.
- Be sure that you are properly grounded (earthed) when touching a static-sensitive component or assembly.
- Avoid touching pins, leads, or circuitry.
- Use nonconductive field service tools.

Symbols on Equipment

These symbols may be located on equipment in areas where hazardous conditions may exist.

Any product or assembly marked with these symbols indicates that the \langle component exceeds the recommended weight for one individual to handle safely.

66 kg 160 lb WARNING: To reduce the risk of personal injury or damage to the equipment, observe local occupational health and safety requirements and guidelines for manual material handling.



Any surface or area of the equipment marked with these symbols indicates the presence of a hot surface or a hot component.

WARNING: To reduce the risk of injury from a hot component, allow the surface to cool before touching it.



Any surface or area of the equipment marked with these symbols indicates the presence of electrical shock hazards. The enclosed area contains no operator-serviceable parts.

WARNING: To reduce the risk of injury from electrical shock hazards, do not open this enclosure.



Any RJ-45 receptacle marked with these symbols indicates a network interface connection.

WARNING: To reduce the risk of electric shock, fire, or damage to the equipment, do not plug telephone or telecommunications connectors into this receptacle.

Rack Warnings and Cautions

WARNING: To reduce the risk of personal injury or damage to the equipment, adequately stabilize the rack before extending a component outside the rack. Extend only one component at a time. A rack may become unstable if more than one component is extended.



WARNING: To reduce the risk of personal injury or damage to the equipment:

- Extend the leveling jacks to the floor.
- Rest the full weight of the rack on the leveling jacks.
- Attach the stabilizers to the rack, if it is a single rack installation.
- Couple the racks together in multiple rack installations.



WARNING: When installing the server in a telco rack, adequately secure the rack frame to the building structure at the top and bottom.

WARNING: To reduce the risk of personal injury or damage to the equipment, use two or more people to safely unload the rack from the pallet. An empty 42U rack weighs 115 kg (253 lb), is over 2.1 m (7 ft) tall, and may become unstable when moved on its casters. Handle the rack from both sides as it rolls down the ramp from the pallet. Do not stand in front of the rack.



CAUTION: Always begin by mounting the heaviest item on the bottom of the rack. Continue to populate the rack from the bottom to the top.

Server Warnings and Cautions



WARNING: Do not exceed the level of repair specified in the procedures in the product documentation. All troubleshooting and repair procedures are detailed to allow only subassembly or module-level repair. Because of the complexity of the individual boards and subassemblies, do not attempt to make repairs at the component level or to make modifications to any printed wiring board. Improper repairs can create a safety hazard.



WARNING: To reduce the risk of personal injury from hot surfaces, allow the hot-plug drives and the internal system components to cool before touching.



WARNING: To reduce the risk of electric shock or damage to the equipment:

- Do not disable the AC power cord grounding plug. The grounding plug is an important safety feature.
- Plug the power cord into a grounded (earthed) electrical outlet that is easily accessible at all times.
- Unplug the power cord from each power supply to disconnect power to the equipment.



WARNING: Before lifting the server, remove all hot-plug power supplies and hard drives to reduce weight.



WARNING: The installation of internal options and routine maintenance and service of this product should be performed by individuals who are knowledgeable about the procedures, precautions, and hazards associated with equipment containing hazardous energy levels.



WARNING: Do not use conductive tools that could bridge live parts. Remove all watches, rings, or loose jewelry when working in hot-plug areas of an energized server.



WARNING: Do not replace non-hot-pluggable components while power is applied to the product. First, shut down the product and disconnect all AC power cords.

WARNING: Be sure that the AC power supply branch circuit that provides power to the rack is not overloaded. Maintaining a low electrical current draw reduces the risk of personal injury, fire, or damage to the equipment. The total rack load should not exceed 80 percent of the branch circuit rating. Consult the electrical authority having jurisdiction over your facility for wiring and installation requirements.



CAUTION: Protect the server from power fluctuations and temporary interruptions with a regulating uninterruptible power supply (UPS). This device protects the hardware from damage caused by power surges and voltage spikes and keeps the system in operation during a power failure.



CAUTION: Do not operate the server for extended periods without the access panel. Operating the server without the access panel results in improper airflow and improper cooling that can lead to thermal damage.

CAUTION: Reinstall each hard drive into the specific slot from which it was removed. Mixing the hard drives adversely affects the system drive configuration.

Accessing Server Components

In order to access components in the server, any or all the following procedures may be required:

- Extending the server from the rack
- Opening the hot-plug door
- Removing the front bezel door (tower model only)
- Removing the rack bezel (rack model only)
- Removing the access panel
- Opening the system tray

All procedures can be performed without powering down the server or causing system shutdown.

Extending the Server from the Rack

To extend the server from the rack:

1. Loosen the front panel thumbscrews that secure the server to the front of the rack (1).

WARNING: To reduce the risk of personal injury, be careful when pressing the server rail release latches and sliding the component into or out of the rack. The sliding rails could pinch your fingertips.

2. Extend the server until the server rail release latches engage (2).



Figure 2-1: Extending the server from the rack

To slide the server back into the rack after performing the maintenance procedure:

- 1. Press the server rail release latches.
- 2. Slide the server fully into the rack.
- 3. Secure the server by tightening the thumbscrews.

Opening the Hot-Plug Door

To open the hot-plug door:

- 1. Extend the server from the rack. Refer to "Extending the Server from the Rack" in this chapter.
- 2. Locate the hot-plug door key. The key is located inside the front bezel door on the tower model servers (1) or in a bag attached to the rear handle on the rack model servers (2).



Fig 2-2: Locating the hot-plug door and front bezel door keys

- 3. Unlock both locks on the hot-plug door (1).
- 4. Slide the hot-plug door latches open (2).
- 5. Open the hot-plug door (3).



Figure 2-3: Opening the hot-plug door

Reverse steps 3 through 5 to close the hot-plug door.

Removing the Front Bezel Door (Tower Model Only)



WARNING: To reduce the risk of personal injury from hot surfaces, allow the internal system components to cool before handling the components.

To remove the front bezel door:

1. Unlock the front bezel door.



Figure 2-4: Unlocking the front bezel door

- 2. Swing open the front bezel door fully.
- 3. Lift the front bezel door, and pull the door away from the chassis hinges.



Figure 2-5: Removing the front bezel door (tower model only)

Reverse steps 1 through 3 to replace the front bezel door.

Removing the Rack Bezel (Rack Model Only)

To remove the rack bezel:

- 1. Remove the four Torx T-15 screws (two per side) securing the rack bezel to the chassis (1).
- 2. Pull the rack bezel away from the chassis (2).



Figure 2-6: Removing the rack bezel (rack model only)

Reverse steps 1 and 2 to replace the rack bezel.

Removing the Access Panel

To remove the access panel:

- 1. Open the front bezel door (tower model only) and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 2. Extend the server from the rack (rack model only). Refer to "Extending the Server from the Rack" in this chapter.

- 3. Loosen the thumbscrews on the front of the chassis (1).
- 4. Use the Torx T-15 tool that ships with the server to loosen the retaining screw located on the front of the chassis next to the two thumbscrews (2).
- 5. Slide the access panel toward the back of the server, and lift it away from the chassis (3).



Figure 2-7: Removing the access panel

Reverse steps 1 through 5 to replace the access panel.

Opening the System Tray

To open the system tray:

1. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.

- 2. Press the latch adjacent to the system tray release handle to release the system tray (1).
- 3. Grasp the system tray release handle and pull the tray from the chassis until it stops in the extended position (2).

NOTE: If the server is mounted into a rack, the system tray latches can be reached more easily by extending the server from the rack (approximately the depth of the drives) before sliding the system tray from the back of the chassis.



Figure 2-8: Opening the system tray

Memory

This section provides the following information about the memory components and procedures for hot-plug and non-hot-plug removal and replacement of memory in the server.

- Parts of the memory board
- Memory board LEDs and icons
- DIMM installation requirements
- Removing a memory board
- Removing a DIMM
- Installing a DIMM
- Installing a memory board
- Configuring the memory

Parts of the Memory Board



Figure 2-9 and Table 2-1 identify the parts of the memory board.

Figure 2-9: Parts of the memory board

	Table 2-1:	Parts of	the Memory	Board
--	------------	----------	------------	-------

Item	Description
1	DIMM slot 1, bank A (populated)
2	DIMM slot 2, bank A (populated)
3	DIMM slot 3, bank B
4	DIMM slot 4, bank B
5	DIMM slot 5, bank C
6	DIMM slot 6, bank C
7	DIMM slot 7, bank D*
8	DIMM slot 8, bank D*
9	LEDs
10	Locking switch
11	Release latches
12	Ejector levers

*When the server is configured for online spare memory, Bank D on memory board 1 is the online spare bank.

Memory Board LEDs and Icons



Use Figure 2-10 and Tables 2-2 through 2-6 to identify LEDs and icons on the memory board.

Figure 2-10: Memory board LEDs and icons

Item	Description	Indicator	Status
1	Memory	Off	Memory board is offline.
Status	Green	Memory board is online.	
	Flashing green	Memory board is busy.	
		Amber	Memory error has occurred on this memory board.
8	DIMM 1-8	Off	DIMM is not installed.
status	Green	DIMM is installed.	
	Amber	Memory error has occurred on this DIMM.	
		Flashing amber	Configuration error has occurred.
1-4, 7, 8	All LEDs	Flashing amber	Memory board is in use; relock it immediately.

Table 2-2: Advanced ECC (Standard) Memory LEDs

Item	Description	Indicator	Status
1 Memory		Off	Memory board is offline.
	Status	Green	Memory board is online.
		Flashing green	Memory board is busy.
		Amber	Memory error has occurred on this memory board.
2	Online Spare Status	Off	Memory board is not configured for online spare memory.
	Green	Online spare memory is functioning properly.	
		Amber	Memory error has occurred and system has failed over to the online spare bank.
7	Online Spare	Off	Bank is not configured as an online spare bank.
text	Green	Bank is configured as an online spare bank.	
		Flashing green	Failure has occurred and online spare bank is active.
8	DIMM 1-8	Off	DIMM is not installed.
Status	Status	Green	DIMM is installed.
		Amber	Memory error has occurred on this DIMM.
		Flashing amber	Configuration error has occurred.
1-4, 7, 8	All LEDs	Flashing amber	Memory board is in use; relock it immediately.

Table 2-3: Online Spare Memory LEDs

Item	Description	Indicator	Status
1	Memory Status	Off	Memory board is offline.
		Green	Memory board is online.
		Flashing green	Memory board is busy.
		Amber	Memory error has occurred on this memory board.
3	Mirroring Status	Off	Memory board is not configured for mirrored memory.
		Green	Single-board mirrored memory is functioning properly.
		Amber	Memory error has occurred and system has failed over to the mirrored bank(s).
8	DIMM 1-8 status	Off	DIMM is not installed.
		Green	DIMM is installed.
		Amber	Memory error has occurred on this DIMM.
		Flashing amber	Configuration error has occurred.
1-4, 7, 8	All LEDs	Flashing amber	Memory board is in use; relock it immediately.

 Table 2-4:
 Single-Board Mirrored Memory LEDs

Item	Description	Indicator	Status
1	Memory Status	Off	Memory board is offline.
		Green	Memory board is online.
		Flashing green	Memory board is busy.
		Amber	Memory error has occurred on this memory board.
3	Mirroring Status	Off	Memory board is not configured for mirrored memory.
		Green	Hot-plug mirrored memory is functioning properly.
		Amber	Memory error has occurred and system has failed over to the mirrored board.
4	Ready to Hot Plug	Off	Do not remove memory board—memory board is not ready for removal.
		Green	Okay to remove memory board.
8	DIMM 1-8 status	Off	DIMM is not installed.
		Green	DIMM is installed.
		Amber	Memory error has occurred on this DIMM.
		Flashing amber	Configuration error has occurred.
1-4, 7, 8	All LEDs	Flashing amber	Memory board is in use; relock it immediately.

Table 2-5: Hot-Plug Mirrored Memory LEDs

Table 2-6: Memory Board Icons

Item	Description	Status
5	Lock	Memory board is locked and cannot be removed.
6	Unlock	Memory board is unlocked; do not remove unless the server is off.

Note: The icon at which the memory board switch is pointed indicates whether the memory board is locked or unlocked.

DIMM Installation Requirements

Observe the following DIMM configuration requirements when installing DIMMs:

- Use only industry-standard PC1600 registered DDR SDRAM DIMMs in 256-MB, 512-MB, 1-GB, and 2-GB capacities.
- Install DIMMs in pairs, one bank at a time.
- Be sure that both DIMMs in a bank are the same capacity.
- Be sure that bank A is populated.

IMPORTANT: HP recommends that you use only HP DIMMs. Third-party DIMMs may have additional installation requirements. For information about third-party DIMM installation requirements, refer to the *HP Advanced Memory Protection* white paper at www.hp.com.

IMPORTANT: You must power down the server before installing additional DIMMs.

IMPORTANT: Follow all DIMM configuration requirements carefully. If the DIMMs are not configured properly, you receive an error message during POST.

The server supports three types of optional Advanced Memory Protection:

- Online spare memory
- Single-board mirrored memory
- Hot-plug mirrored memory

Each type includes Advanced ECC protection.

Additional Requirements for Online Spare Memory Technology

In addition to the DIMM configuration requirements for advanced ECC memory, observe the following DIMM configuration requirements when installing DIMMs for online spare memory:

- Bank D is the online spare bank and must be populated when the server is configured for online spare memory.
- DIMMs installed in the online spare bank must be of equal or greater capacity than each of those in the remaining banks.

Additional Requirements for Single-Board Mirrored Memory Technology

In addition to the DIMM configuration requirements for advanced ECC memory, observe the following DIMM configuration requirements when installing DIMMs for single-board mirrored memory:

- Bank C mirrors bank A, and bank D mirrors bank B. Banks A and C must always be populated.
- DIMMs in the mirrored banks must be configured identically to the banks they are mirroring. Corresponding banks (for instance, bank A and bank C) must be populated with DIMMs of the same capacity.

Additional Requirements for Hot-Plug Mirrored Memory Technology

In addition to the DIMM configuration requirements for advanced ECC memory, observe the following DIMM configuration requirements when installing DIMMs for hot-plug mirrored memory:

- Two memory boards must be installed.
- Both memory boards must be configured identically. Corresponding banks (for instance, bank A on the memory board in slot 1 and bank A on the memory board in slot 2) must be populated with DIMMs of the same capacity.

Removing a Memory Board

CAUTION: Electrostatic discharge can damage electronic components. Make sure you are properly grounded before beginning any installation procedure.

To remove a memory board:

1. If the server is not configured for hot-plug mirrored memory, you must power down the server. Refer to "Powering Down the Server" in this chapter.

If the server is configured for hot-plug mirrored memory, skip to step 2.

2. Open the hot-plug door. Refer to "Opening the Hot-Plug Door" in this chapter.

Hot-replacement procedure: Determine which memory board you want to remove by locating the memory board with an amber memory status LED and one or more amber DIMM status LEDs. The Ready to Hot Plug LED must be green, indicating that you can perform a hot-plug procedure.

NOTE: If the Ready to Hot Plug LED is off on both boards, then you must power down the server before replacing DIMMs.

3. Disengage the locking switch (1).

Hot-replacement procedure: After turning the locking switch, the LEDs turn off, except the amber LEDs. Wait until all green LEDs are off before proceeding. Make note of which DIMM status LED remains amber. This is the DIMM you need to remove and replace.

CAUTION: Do not attempt to unlock the memory board in an operational server when the Ready to Hot Plug LED is not green. This generates an audible alarm and causes the memory board LEDs to flash amber. Proceeding to remove the memory board after the audible and visible alarms causes system failure.



CAUTION: To prevent system failure, do not remove the memory board from the server until the memory status LED stops blinking.

- 4. Press the release latches inward firmly (2), disengaging the board from the server. Do not squeeze the latches.
- 5. Lift the ejector levers up (3).
- 6. Pull the memory board up out of the server (4).

Hot-replacement procedure: While the memory board with the failed or degraded DIMM is being replaced, the system continues to read and write from the operational memory board.



Figure 2-11: Removing the memory board

Removing a DIMM

To remove a DIMM:

- 1. Remove the memory board. Refer to "Removing a Memory Board" in this chapter.
- 2. Place the memory board on a level surface.
- 3. Open the DIMM slot latches (1) and remove the DIMM from the DIMM slot (2).



Figure 2-12: Removing a DIMM
Installing a DIMM

To install a DIMM:

- 1. Remove the memory board. Refer to "Removing a Memory Board" in this chapter.
- 2. Observe all DIMM installation requirements for the desired memory mode. Refer to the "DIMM Installation Requirements" section in this chapter for each mode.

IMPORTANT: Follow all DIMM configuration requirements carefully. If the DIMMs are not configured properly, you will receive an error message during POST and the DIMM LEDs will blink amber.

3. Align the keyed portion of the bottom edge of the DIMM with the tab in the DIMM slot.

IMPORTANT: The bottom edge of the DIMM is designed so that it fits into the DIMM slot only one way.

- 4. Press the DIMM firmly into the slot (1).
- 5. Push the latches into place (2).



Figure 2-13: Installing and latching a DIMM

Installing a Memory Board

To install a memory board:

- 1. Align the memory board with the memory slot and memory board guide clips.
- 2. Slide the memory board into the server (1), and close the ejector levers to seat the memory board firmly (2).

Hot-replacement procedure: Any LEDs that were amber when the board was removed from the server now illuminate amber again.

IMPORTANT: The LEDs reilluminate amber during this step to enable you to be sure which DIMM failed. If you have already replaced the failed DIMM, disregard the amber LEDs. The LEDs change back to green after the locking switch is engaged.

3. Engage the locking switch (3).

Hot-replacement procedure: All LEDs now turn off except the memory status LED, which flashes green while data are copied from one memory board to the other. This process may take up to a minute to complete. When the copying process is complete, the other LEDs reilluminate as described in Table 2-7.



CAUTION: Do not remove the memory board while the memory status LED is flashing. When the memory status LED is flashing, the memory board is transferring data. Removing the memory board during data transfer may cause system failure.



Figure 2-14: Installing the memory board

4. If the server is not currently configured for hot-plug mirrored memory, power up the server. Refer to the *HP ProLiant ML570 Generation 2 Server Setup and Installation Guide* on the Documentation CD.

Hot-replacement procedure: If the server is configured for hot-plug mirrored memory, skip to step 7.

5. Configure the memory. Refer to "Configuring the Memory" in this chapter.

6. Reference the LEDs on the top of the memory board to make sure that the memory is functioning properly. The following table describes what the LEDs look like for each memory configuration when the DIMMs and memory board are functioning properly. For more information on LEDs, refer to Chapter 4, "Connectors, LEDs, and Switches."

Memory Configuration Hot-Plug Advanced ECC **Online Spare** Single-Board LED Mirrored (Standard Memory Mirrored Memory Memory) Memory Memory Status Green Green Green Green DIMMs 1-8, if Green Green Green Green populated **Online Spare** Off Green Off Off Status **Mirroring Status** Off Off Green Green Off Off Off **Online Spare** Green Text* Off Off Off Ready to Hot Green Plug

Table 2-7: Memory LED States on a Properly Functioning Memory Board

*If two memory boards are installed, the online spare text is only illuminated for the memory board in slot 1.

NOTE: When the server is configured for online spare memory, Bank D is the online spare bank.

- 7. If any of the LEDs are illuminated solid amber, indicating a failed DIMM, or blinking amber, indicating improper DIMM configuration, refer to the *HP Servers Troubleshooting Guide* on the Documentation CD for instructions.
- 8. Close the hot-plug door.
- 9. Close the front bezel door (tower model only).

Configuring the Memory

Configuring the server's memory system requires configuring both hardware and software.

To configure the memory:

- 1. Remove the memory board. Refer to "Removing a Memory Board" in this chapter.
- 2. Install the required DIMMs based on the desired memory configuration. Be sure to follow all DIMM installation requirements. Refer to the "DIMM Installation Requirements" section in this chapter for each mode.
- 3. Install the memory board. Refer to "Installing a Memory Board" in this chapter.
- 4. Test the DIMMs:
 - a. Power on the server.
 - b. Press the **F9** key to enter RBSU.
 - c. Select Advanced Options.
 - d. Change **POST Speed Up** to **disable**.
 - e. Press any key to return to the RBSU main menu.
 - f. Select System Options.
 - g. Select Advanced Memory Protection.
 - h. Select the desired memory mode.
 - i. Press the Esc key twice to go back to the main RBSU menu.
 - j. Press the **F10** key to exit RBSU. The server reboots and tests all memory in the system.
 - k. Once the memory has been tested, change **POST Speed Up** to **enable** for faster system boot, if desired.

IMPORTANT: To reconfigure the memory mode after initial setup, you must reboot the system and enter RBSU.

Hot-Plug Procedures

You can perform removal/replacement procedures for some server components without powering down the server. The following removal/replacement procedures are hot-plug capable:

- Power supplies
- Processor and I/O fans
- Drive fans
- Front and rear processor air baffles
- SCSI hard drives
- PCI and PCI-X Hot Plug expansion boards (in hot-plug slots)
- Memory (refer to the "Memory" section in this chapter)

Hot-Plug Power Supplies

CAUTION: Do not hot-remove a power supply without a redundant power supply in place.

CAUTION: Hot-plug power supplies for the ProLiant ML570 Generation 2 server are keyed to make sure that only 600-W hot-plug power supplies can be installed in the server. The handles on 600-W power supplies are carbon (black) to distinguish them from other power supplies, which are opal (white).

To remove a hot-plug power supply:

- 1. Release the AC power cord from the tie wrap on the power supply.
- 2. Unplug the AC power cord from the power supply.

3. Remove the retaining screw, if installed.



Figure 2-15: Removing the retaining screw

- 4. Press the latch in the middle of the power supply handle to release the handle (1).
- 5. Pull the handle downward until the unit releases from the server (2).
- 6. Slide the hot-plug power supply from the chassis (3).



Figure 2-16: Removing a hot-plug power supply

CAUTION: A power supply or power supply blank must always be installed in each power supply bay for proper system cooling. If a power supply bay is left open, thermal damage may occur.

Reverse steps 1 through 6 to replace a hot-plug power supply.

For information on power supply diagnosis, refer to "Hot-Plug Power Supply LEDs" in Chapter 4, "Connectors, LEDs, and Switches."

Hot-Plug Fans (Processor and I/O)

The server hot-plug fans are housed in two fan baskets. Each basket holds a primary and a redundant hot-plug fan. The I/O fans cool the system board components, and the processor fans cool the processors.



CAUTION: Never remove both hot-plug fans from either system fan basket while the server is powered up. Overheating and damage to hardware could result. If the appropriate HP software drivers are installed, the operating system software initiates a power shutdown in case of overheating.

To remove a hot-plug processor or I/O fan:

- 1. Remove the front bezel door (tower model only) and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 2. Extend the server from the rack (rack model only). Refer to "Extending the Server from the Rack" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Press and hold the locking latch (1).
- 5. Lift the hot-plug processor or I/O fan out of the fan basket (2).



Figure 2-17: Removing a hot-plug processor or I/O fan

Reverse steps 1 through 5 to replace a hot-plug processor fan or hot-plug I/O fan.

For information on hot-plug fan diagnosis, refer to "Hot-Plug Fan LEDs" in Chapter 4, "Connectors, LEDs, and Switches."

Hot-Plug Fans (Drive)

The server ships standard with three hot-plug drive fans. Two fans are required for operation, and the third fan is redundant.

To remove a hot-plug drive fan:

- 1. Remove the front bezel door (tower model only) and lay the server on its side with the access panel facing upward. Refer to "Removing Front Bezel Door (Tower Model Only)" in this chapter.
- 2. Extend the server from the rack (rack model only). Refer to "Extending the Server from the Rack" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Open the system tray. Refer to "Opening the System Tray" in this chapter.
- 5. Loosen the thumbscrew located at the top of the fan (1).
- 6. Lift the hot-plug drive fan out of the chassis (2).

CAUTION: Hot-plug drive fans are located below all server cabling. Be careful not to unplug or loosen cables when accessing hot-plug drive fans.



Figure 2-18: Removing a hot-plug drive fan

Reverse steps 1 through 6 to replace a hot-plug drive fan.

For information on hot-plug drive fan diagnosis, refer to "Hot-Plug Fan LEDs" in Chapter 4, "Connectors, LEDs, and Switches."

Processor Air Baffles



CAUTION: The removal and replacement of the rear and front processor air baffles must be completed within 1 minute to prevent possible overheating and damage to hardware.

Rear Processor Air Baffle

To remove the rear processor air baffle:

- 1. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 2. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 3. Remove the rear processor air baffle by loosening the two thumbscrews that secure it to the system tray (1).
- 4. Lift the air baffle up and out of the server (2).



Figure 2-19: Removing the rear processor air baffle

Reverse steps 1 through 4 to replace the rear processor air baffle.

Front Processor Air Baffle

To remove the front processor air baffle:

- 1. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 2. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 3. Remove the rear processor air baffle. Refer to "Processor Air Baffles" in this chapter.

4. Loosen the two thumbscrews on the front processor air baffle (1).



5. Lift the processor air baffle from the chassis (2).

Figure 2-20: Removing the front processor air baffle

Reverse steps 1 through 5 to replace the front processor air baffle.

SCSI Hard Drives

Be aware of the following guidelines cautioning unsafe hot-plug hard drive replacement.

- Do not remove a degraded drive if any other member of the array is offline (the online LED is off). No other drive in the array can be hot-plugged without data loss. The exception to this is the use of RAID 1+0 as a fault-tolerant configuration. In this case, drives are mirrored in pairs. More than one drive can fail and be replaced as long as the drive or drives they are mirroring are online.
- Do not remove a degraded drive if any member of an array is missing (previously removed and not yet replaced).
- Do not remove a degraded drive if any member of an array is being rebuilt, unless the drive being rebuilt has been configured as an online spare. The online LED for the drive flashes green or amber, indicating that a replaced drive is being rebuilt from the data stored on the other drives.

NOTE: An online spare drive does not activate and start rebuilding after a predictive failure alert because the degraded drive is still online. The online spare activates only after a drive in the array has failed.

• Do not replace multiple degraded drives at the same time, since the fault tolerance can be compromised. When a drive is replaced, the controller uses data from the other drives in the array to reconstruct data on the replacement drive. If more than one drive is removed, a complete data set is not available to reconstruct data on the replacement drive or drives, and permanent data loss can occur.

CAUTION: Do not turn off any external unit when the server containing the Smart Array Controller is powered up. Also, do not power up the server before powering up the drive enclosure. If these ordering rules are not followed, the Smart Array Controller may mark the drives in this enclosure as "failed," resulting in permanent data loss.

To remove a hard drive:

1. Open the front bezel door (tower model only). Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.



CAUTION: Remove or replace a hard drive only when the drive failure LED is amber. Data loss can occur if a drive is removed when the drive online LED is green. Refer to "Hot-Plug Drive LEDs" in Chapter 4 for more information.



CAUTION: Remove or replace only one hard drive at a time. The controller relies on other drives to reconstruct data on the replaced drive. Drive reconstruction is active when the drive online LED is flashing green.

- 2. Push the sliding release button (1).
- 3. Swing out the ejector lever (2).
- 4. Pull the drive out from the drive cage (3).

CAUTION: Always populate drive bays with either a hard drive or blank. Proper airflow can only be maintained when the bays are populated. Unpopulated drive bays can lead to improper cooling and thermal damage.



Figure 2-21: Removing a hard drive

Reverse steps 1 through 4 to replace a hard drive.

PCI and PCI-X Hot Plug Expansion Boards

CAUTION: Do not attempt a PCI Hot Plug procedure if the operating system does not provide PCI Hot Plug support or if you do not have the appropriate device drivers installed. Failure to take these precautions causes system shutdown and risks data integrity.

CAUTION: To avoid critical errors, do not open the expansion slot latch if the green power LED is on or blinking. Use the PCI Hot Plug button or the software application to turn off power to the slot.

Use either the PCI-X Hot Plug button on the server or the operating system's PCI-X Hot Plug Utility to control the PCI-X Hot Plug slots.

- The PCI-X Hot Plug button and the PCI-X Hot Plug Utility enable you to power up or power down a PCI-X Hot Plug expansion slot. The PCI-X Hot Plug button enables direct access at each hot-plug expansion slot.
- PCI Hot Plug software support for each operating system is available online. For more information, refer to the *PCI Hot Plug Administrator's Guide* on the Documentation CD.

The server includes seven PCI-X expansion slots. Use the Figure 2-22 and Table 2-8 to identify each slot.



Figure 2-22: PCI-X expansion slots

Item	Slot	Bus	
1	Slot 1 (hot-plug)	Shared buc	
2	Slot 2 (hot-plug)		
3	Slot 3 (hot-plug)	Shared hup	
4	Slot 4 (hot-plug)		
5	Slot 5	Shared hup	
6	Slot 6		
7	Slot 7*	PCI-X bus	
*Slot 7 is recommended for the Remote Insight Lights-Out Edition II.			

Table 2-8: PCI-X Expansion Slots and Buses

PCI-X Hot Plug expansion slots are accessible through the hot-plug door.

To remove an expansion board from a PCI-X Hot Plug slot:

- 1. Extend the server from the rack (rack model only). Refer to "Extending the Server from the Rack" in this chapter.
- 2. Open the hot-plug door. Refer to "Opening the Hot-Plug Door" in this chapter.

3. Press the port-colored PCI-X Hot Plug button to power down the slot (1). The power LED flashes until shutdown is complete. Refer to "PCI-X Hot Plug LEDs" in Chapter 4, "Connectors, LEDs, and Switches," to determine the current PCI-X Hot Plug slot status.

CAUTION: To prevent data loss, do **not** open an expansion slot latch when the power LED for the slot is on.

- 4. When the power LED for the slot is off, remove cables to the selected expansion board.
- 5. Push the tab on the expansion slot latch (2).
- 6. Swing the latch back to unlock the expansion board (3).



Figure 2-23: Pushing the PCI-X Hot Plug button and releasing the expansion slot latch

- 7. Release the PCI-X retaining clip (1).
- 8. Lift the expansion board release handle to lift the board from the slot (2).
- 9. Remove the board from the slot (3).



Figure 2-24: Removing a PCI-X Hot Plug expansion board

Before replacing the expansion board, review the following information:

- Balancing is the paired arrangement of expansion boards for optimal performance based on the bus architecture of the expansion slots. Properly balancing the expansion boards across buses can improve performance.
- To balance expansion boards, populate slots across different buses before populating two slots on the same bus.

Table 2-9 provides a guideline for slot population order.

NOTE: The slot population order that follows is a recommendation only; any PCI or PCI-X expansion board may reside in any slot.

Slot Number	Population Order		
1	1	— Shared PCI-X bus	
2	5		
3	2	— Shared PCI-X bus	
4	6		
5	3	 Shared PCI-X bus 	
6	7		
7*	4	PCI-X bus	
*Slot 7 is recommended for the Remote Insight Lights-Out Edition II due to			

 Table 2-9: Recommended PCI-X Expansion Slot Population Order

internal cabling requirements.

The operating system detects the PCI devices in the slots in this order:

1-2-3-4-5-6-7

For more information about PCI bus architecture and numbering, refer to the white paper, *PCI Bus Numbering in a Windows NT Environment*, at

www.hp.com/servers/proliant/manage

Reverse steps 1 through 9 to replace the expansion board.

Preparing the Server for Non-Hot-Plug Procedures

Before replacing non-hot-plug devices, the following procedures must be performed:

- Power down the server
- Extend the server from the rack
- Remove the server from the rack

Powering Down the Server



WARNING: It is necessary to be knowledgeable of electrostatic discharge information before preparing the server. For electrostatic discharge information, refer to "Electrostatic Discharge Information" in this chapter.

To power down the server:

- 1. Remove the front bezel door (tower model only). Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 2. Press the Power On/Standby button.



Figure 2-25: Pressing the Power On/Standby button

- 3. Be sure that the front panel power LED indicator is amber and that the fans are off.
- 4. Disconnect all AC power cords from the server.
- 5. Disconnect all external peripheral devices from the server.

Extending the Server from the Rack

To extend the server from the rack:

- 1. Loosen the front panel thumbscrews that secure the server to the front of the rack (1).
- 2. Extend the server until the server rail release latches engage (2).



Figure 2-26: Extending the server from the rack

Removing the Server from the Rack

WARNING: To reduce the risk of personal injury or damage to the equipment, observe local occupational health and safety requirements and guidelines for manual material handling.

WARNING: Before lifting the server, remove all hot-plug power supplies to reduce

weight.



WARNING: The server is very heavy, up to 66 kg (146 lb). To reduce the risk of personal injury or damage to the equipment:

- Remove all hot-plug power supplies to reduce the weight of the server before lifting it.
- Observe local occupational health and safety requirements and guidelines for manual material handling.
- Use more than one person to lift and stabilize the server.

To remove the server from the rack:

- 1. Power down the server. Refer to "Powering Down the Server" in this chapter.
- 2. Loosen the thumbscrews that hold the cable management arm bracket to the back of the server (1).
- 3. Slide the cable management arm bracket up and remove it from the server (2).



Figure 2-27: Removing the cable management arm

- 4. Loosen the front panel thumbscrews and pull the server out of the front of the rack until it stops in the extended position.
- 5. Press the release latches.



Figure 2-28: Pressing the release latches

6. Pull the server out of the front of the rack.



Figure 2-29: Removing the server from the rack

7. Place the server on a nonconductive, level surface.

Non-Hot-Plug Procedures

In order to remove or replace any non-hot-plug component, you must first power down the server. The following non-hot-plug procedures are described in this section.

- System Battery
- Processor Power Modules (PPMs)
- Processors
- Expansion Boards
- Hot-Plug Expansion Board Basket
- PCI Backplane
- System Tray
- Power Backplane
- Fan Basket
- Processor Fan Bracket with Cable
- Drive Air Baffle
- CD-ROM Drive
- Diskette Drive
- Removable Media Devices

- Internal Two-Bay Hot-Plug SCSI Drive Cage Fans (Optional)
- Drive Cage Backplane
- Drive Fan Cable and Cable Bracket
- Front Panel LED Assembly

System Battery



CAUTION: Loss of BIOS settings occurs when the system battery is removed. BIOS settings must be reconfigured whenever the battery is replaced. Power up the server and run RBSU.



WARNING: This server contains an internal lithium manganese dioxide or vanadium pentoxide battery. A risk of fire and burns exists if the battery pack is not handled properly. To reduce the risk of personal injury:

- Do not attempt to recharge the battery.
- Do not expose to temperatures higher than 60°C (140°F).
- Do not disassemble, crush, puncture, short external contacts, or dispose of in fire or water.
- Replace only with the HP spare designated for this server.



CAUTION: Do not dispose of batteries, battery packs, and accumulators with the general household waste. To forward them to recycling or proper disposal, use the public collection system or return them to either HP or the nearest HP authorized service provider.

To remove the battery:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.

4. Locate the battery on the system board.



Figure 2-30: Battery location on system board

- 5. Press the battery release lever away from the battery (1).
- 6. Lift the battery on the lever side and pull it out of the holder (2).



Figure 2-31: Removing the battery from the system board

Reverse steps 1 through 6 to replace the battery.

Processor Power Modules (PPMs)

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Remove the rear and front processor air baffles. Refer to "Processor Air Baffles" in this chapter.
- 5. Loosen the thumbscrew on the processor retaining bracket (1).
- 6. Lift the processor retaining bracket upward (2).



Figure 2-32: Lifting the processor retaining bracket

7. Lift the PPM straight up from its slot.



Figure 2-33: Removing a PPM

Reverse steps 1 through 7 to replace a PPM.

IMPORTANT: When installing a PPM, be sure the key slot in the PPM is aligned with the key in the slot.

Processors

To remove a processor:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Remove the rear and front processor air baffles. Refer to "Processor Air Baffles" in this chapter.

- 5. Loosen the thumbscrew on the processor retaining bracket (1).
- 6. Lift the retaining bracket upward (2).
- 7. Remove the PPM. Refer to "Processor Power Modules (PPMs)" in this chapter.
- 8. Move the processor locking lever to the unlocked position (3).



Figure 2-34: Lifting the processor retaining bracket and the processor locking lever

9. Lift the processor/heatsink assembly straight up from its socket.



Figure 2-35: Removing the processor/heatsink assembly

Reverse steps 1 through 9 to replace a processor.

CAUTION: Do not force the processor into the processor socket. The processor pins are fragile, and the processor socket is keyed to ensure proper installation.

NOTE: When inserting a processor into a socket, determine the correct processor orientation by observing the keyed configuration of both the processor socket and the processor pins.

Expansion Boards

To remove a non-hot-plug expansion board:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Disconnect the cables from the expansion board.
- 5. Press the PCI-X retaining clip, releasing one side of the board.



Figure 2-36: Pressing the PCI-X retaining clip

- 6. Push the tab on the slot release lever (1).
- 7. Swing the lever back to unlock the expansion board (2).
- 8. Lift the expansion board from the slot (3).



Figure 2-37: Removing an expansion board from a non-hot-plug slot

Reverse steps 1 through 8 to replace an expansion board.

Hot-Plug Expansion Board Basket

To remove the hot-plug expansion board basket:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Remove cables to all PCI-X Hot Plug expansion boards (slots 1 through 4).
- 5. Remove all PCI-X Hot Plug expansion boards from the basket. Refer to "PCI and PCI-X Hot Plug Expansion Boards" in this chapter.

IMPORTANT: If no expansion board is installed in PCI-X slot 1, remove the expansion slot cover.

- 6. Remove the Torx T-15 screw holding the basket in place. The screw is located between slots 3 and 4 in the rear (1).
- 7. Pull up on the retaining pins securing the hot-plug expansion board basket to the system tray (2).
- 8. Press the plastic sleeve outward until the retaining tab snaps clear of the rear panel (3).
- 9. Lift the hot-plug expansion board basket from the system tray (4).



Figure 2-38: Removing the hot-plug expansion board basket

Reverse steps 1 through 9 to replace the hot-plug expansion board basket.

PCI Backplane

To remove the PCI backplane:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Remove the memory board. Refer to "Removing the Memory Board" in this chapter.

5. Disconnect the cable from the PCI backplane.



Figure 2-39: Disconnecting the cable from the PCI backplane (PCI basket removed for clarity)

- 6. Open an expansion slot latch and remove the expansion board or expansion slot cover. Refer to the "PCI and PCI-X Hot Plug Expansion Boards" section in this chapter.
- 7. Remove the expansion slot latch:
 - a. Press upward on the bottom of the clear plastic latch from the outside of the chassis (1).
 - b. Pull the latch away from the inner wall of the chassis (2).



Figure 2-40: Removing an expansion slot latch

8. Repeat steps 6 and 7 for each remaining expansion slot.

- 9. Remove both plastic rivets from the PCI backplane:
 - a. From inside the chassis, use a pointed tool to push the center pin out through the front of the rivet.
 - b. Pull the pin completely from the rivet and set aside.
 - c. Remove the rivet.



Figure 2-41: Removing the PCI backplane rivets

IMPORTANT: Do not discard the rivets or pins.

- 10. Open the system tray. Refer to the "Opening the System Tray" section in this chapter.
- 11. Lift the PCI backplane up and out of the server.



Figure 2-42: Removing the PCI backplane

Reverse steps 1 through 11 to replace the PCI backplane.

System Tray

WARNING: To reduce the risk of personal injury or damage to the equipment, do not use the system tray handle to lift or move the ProLiant ML570 Generation 2 server.

To remove the system tray:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Remove the processor air baffles. Refer to "Processor Air Baffles" in this chapter.
- 5. Remove the memory boards. Refer to "Removing a Memory Board" in this chapter.
- 6. Disconnect cables to all PCI expansion boards.
- 7. Remove any expansion boards from the PCI slots. Refer to "Expansion Boards" in this chapter.

- 8. Press the latch adjacent to the system tray release handle to release the system tray (1).
- 9. Grasp the system tray release handle and pull the tray from the chassis until it stops in the extended position (2).
- 10. Disconnect all internal cables connected to the system tray. For cable routing information, refer to "Cable Routing Diagrams" in this chapter.

CAUTION: Do not pull the system tray completely out from the server unless all cables have been disconnected.

- 11. Push and hold the latches on either side of the system tray (3).
- 12. Slide the system tray out from the chassis (4).



Figure 2-43: Removing the system tray

- 13. Place the system tray on a level nonconductive surface.
- 14. Be sure that the system switch settings on the system tray you are installing match those on the system tray you are removing. Refer to "System Board Switches" in Chapter 4 "Connectors, LEDs, and Switches."
- 15. Transfer all memory boards, expansion boards, PPMs, and processors onto the new system board. Refer to the appropriate sections in this chapter regarding the removal of these components.

IMPORTANT: Be sure that all components occupy the same locations in the new tray as they did on the failed one. Failure to configure the new board exactly like the failed one may result in data loss.

Reverse steps 1 through 12 to replace the system tray.

IMPORTANT: The server serial number must be re-entered through RBSU after replacing the system tray. Refer to "Re-entering the Server Serial Number" in this chapter.

Power Backplane

To remove the power backplane:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Open the system tray. Refer to "Opening the System Tray" in this chapter.
- 5. Disconnect all cables from the power backplane. Refer to "Cable Routing Diagrams" in this chapter.
- 6. Loosen the two Torx T-15 thumbscrews (1).
- 7. Slide the power backplane toward the rear of the server and lift from the chassis (2).



Figure 2-44: Removing the power backplane

CAUTION: To avoid damaging the cable when sliding the system tray, be sure that all the power cables are connected securely in the power backplane cavity.

Reverse steps 1 through 7 to replace the power backplane.

Fan Basket

The fan baskets house the hot-plug fans that cool the processors and boards.

CAUTION: To maintain proper cooling, at least one fan in each fan basket must be operational.

CAUTION: Never remove both hot-plug fans from either system fan basket while the server is powered up. Overheating and damage to hardware could result. If the appropriate HP software drivers are installed, the operating system software initiates a power shutdown in case of overheating.

To remove the fan basket:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Extend the server from the rack (rack model only). Refer to "Extending the Server from the Rack" in this chapter.
- 4. Remove the hot-plug fans. Refer to "Hot-Plug Fans (Processor and I/O)" in this chapter.
- 5. Loosen the thumbscrew that secures the fan basket to the chassis (1).
- 6. Remove the fan basket from the chassis (2).



Figure 2-45: Removing the fan basket

Reverse steps 1 through 6 to replace the fan basket.

Processor Fan Bracket

To remove the processor fan bracket:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Remove the hot-plug fans. Refer to "Hot-Plug Fans (Processor and I/O)" in this chapter.
- 5. Remove the fan basket. Refer to "Fan Basket" in this chapter.
- 6. Open the system tray. Refer to "Opening the System Tray" in this chapter.
- 7. Disconnect the processor fan bracket power cable from the system board.
- 8. Remove the four Torx T-15 screws securing the processor fan bracket to the chassis (1).
- 9. Slide the bracket toward the center of the chassis and lift the bracket out of the chassis (2).



Figure 2-46: Removing the processor fan bracket

Reverse steps 1 through 9 to replace the processor fan bracket.

Drive Air Baffle

To remove the drive air baffle:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Remove the hot-plug fans. Refer to "Hot-Plug Fans (Processor and I/O)" in this chapter.
- 5. Remove both fan baskets. Refer to "Fan Basket" in this chapter.
- 6. Open the system tray. Refer to "Opening the System Tray" in this chapter.

NOTE: To facilitate removal of the drive air baffle, you may wish to remove the two outer hot-plug drive fans. Refer to "Hot-Plug Fans (Drive)" in this chapter.

- 7. Loosen the thumbscrews on the drive air baffle (1).
- 8. Slide the air baffle over the drive fans, and lift the drive air baffle away from the chassis (2).



Figure 2-47: Removing the drive air baffle

Reverse steps 1 through 8 to replace the drive air baffle.
CD-ROM Drive

To remove the CD-ROM drive:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Remove the hot-plug processor fan. Refer to "Hot-Plug Fans (Processor and I/O)" in this chapter.
- 5. Remove the fan basket. Refer to "Fan Basket" in this chapter.
- 6. Remove the processor fan bracket. Refer to "Processor Fan Bracket" in this chapter.
- 7. Open the system tray. Refer to "Opening the System Tray" in this chapter.
- 8. Disconnect the power and signal cables from the CD-ROM drive. Refer to "Diskette and CD-ROM Drive Cables" in this chapter.
- 9. Loosen the thumbscrew located near the bottom of the fan basket to release the metal locking bracket (1).
- 10. Slide the metal locking bracket outward (2).
- 11. Push the CD-ROM drive out of the front of the chassis (3).



Figure 2-48: Removing the CD-ROM drive

Reverse steps 1 through 11 to replace the CD-ROM drive.

Diskette Drive

To remove the diskette drive:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Remove the hot-plug processor fan. Refer to "Hot-Plug Fans (Processor and I/O)" in this chapter.
- 5. Remove the hot-plug processor fan basket. Refer to "Fan Basket" in this chapter.
- 6. Disconnect the power and signal cables from the diskette drive. Refer to "Diskette and CD-ROM Drive Cables" in this chapter.
- 7. Loosen the thumbscrew on the side of the diskette drive (1).
- 8. Slide the drive back and lift it from the chassis (2).



Figure 2-49: Removing the diskette drive

Reverse steps 1 through 8 to replace the diskette drive.

Removable Media Devices

The removable media area contains two bays that can house up to two media devices each. A media bay with no devices installed must be covered with a removable media blank. To remove an installed media device:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only). Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Disconnect all cabling from the removable media device.
- 5. Slide the blue plastic locking lever on the outside of the removable media area to release the media device (1).
- 6. Pull the media device from the removable media area (2).

CAUTION: Always populate removable media bays with either a hard drive or blank. Proper airflow can only be maintained when the bays are populated. Unpopulated media bays can lead to improper cooling and thermal damage.



Figure 2-50: Removing a media device from the removable media area

Reverse steps 1 through 6 to replace a removable media device or to cover the opening with a removable media blank.

NOTE: Removable media bay devices may not always sit flush with the server when correctly inserted.

NOTE: When replacing a removable media device with a new device, the bay-blank rails must be transferred onto the new device being installed.

Internal Two-Bay Hot-Plug SCSI Drive Cage Fans (Optional)

To remove the internal two-bay hot-plug SCSI drive cage fans:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Disconnect all cabling from the removable media device.
- 5. Remove the removable media device from the removable media area. Refer to "Removable Media Devices" in this chapter.



CAUTION: Always populate media bays with either a hard drive or blank. Proper airflow can only be maintained when the bays are populated. Unpopulated media bays can lead to improper cooling and thermal damage.

- 6. Lift the clip holding the fans to the back of the drive cage (1).
- 7. Remove the fans from the rear of the drive cage (2).



Figure 2-51: Removing fans from the rear of the internal two-bay hot-plug SCSI drive cage

8. Disconnect the fan cable from the back of the drive cage.

Reverse steps 1 through 8 to replace the internal two-bay hot-plug SCSI drive cage fans.

Drive Cage Backplane

The server ships standard with two drive cages that support up to 12 drives.

CAUTION: If the server is set up in an array configuration and an active drive is replaced while the system is powered down, the following POST drive error message (1786) occurs when the system is powered up: PRESS <F1> TO BOOT THE SYSTEM AND REBUILD THE REPLACED

DRIVE, OR PRESS <F2> TO BOOT THE SYSTEM AND REBUILD THE REPLACED THE DRIVE (S).

Pressing the **F2** key causes permanent data loss to the logical drive. The **F2** key should be pressed only when all the drives are replaced or when complete data loss is desired.

NOTE: When a drive configured for fault tolerance is replaced, the replacement drive automatically begins reconstruction. Drive reconstruction is active when the drive online LED is flashing green.

To remove the drive cage backplane:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only). Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove rack bezel (rack model only). Refer to "Removing the Rack Bezel (Rack Model Only)" in this chapter.
- 4. Remove all drives from the drive cage to be replaced. Refer to "SCSI Hard Drives" in this chapter.

CAUTION: Hard drives must be reinserted in the same locations from which they were removed. Reinserting hard drives in different orders and locations may result in data loss.

- 5. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 6. Remove the hot-plug fans. Refer to "Hot-Plug Fans (Processor and I/O)" in this chapter.
- 7. Remove the fan baskets. Refer to "Fan Basket" in this chapter.
- 8. Open the system tray. Refer to "Opening the System Tray" in this chapter.
- 9. Remove the hot-plug drive fans. Refer to "Hot-Plug Fans (Drive)" in this chapter
- 10. Remove the drive air baffle. Refer to "Drive Air Baffle" in this chapter.
- 11. Disconnect the cables attached to the drive cage. Refer to "SCSI Cables" and "SCSI Backplane Power Cables" in this chapter.

12. Remove the four T-15 screws securing the drive cage to the chassis (1).



13. Pull the drive cage assembly from the front of the chassis (2).

Figure 2-52: Removing the drive cage

- 14. Remove the two Torx T-15 screws that hold the drive cage backplane to the drive cage (1).
- 15. Lift the backplane upward, then outward to release it from the drive cage (2).



Figure 2-53: Removing the drive cage backplane

Reverse steps 1 through 15 to replace the hard drive cage or cover the opening with a drive cage blank to maintain proper cooling.

Drive Fan Cable and Cable Bracket

To remove the drive fan cable and cable bracket:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 4. Remove the hot-plug fans. Refer to "Hot-Plug Fans (Processor and I/O)" in this chapter.
- 5. Remove the fan baskets. Refer to "Fan Basket" in this chapter.
- 6. Remove the hot-plug drive fans. Refer to "Hot-Plug Fans (Drive)" in this chapter.
- 7. Remove the drive air baffle. Refer to "Drive Air Baffle" in this chapter.
- 8. Remove the drive cage. Refer to "Drive Cage Backplane" in this chapter.
- 9. Remove the Torx T-10 screw holding the drive fan cable bracket in place (1), and lift the drive fan cable bracket from the chassis.
- 10. Disconnect the drive fan power cable from the power backplane (2).



Figure 2-54: Removing the drive fan cable and cable bracket

11. Remove the drive fan cable from the unit.

Reverse steps 1 through 11 to replace the drive fan cable and cable bracket.

Front Panel LED Assembly

To remove the front panel LED assembly:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Remove the front bezel door (tower model only), and lay the server on its side with the access panel facing upward. Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 3. Remove the rack bezel (rack model only). Refer to "Rack Bezel (Rack Model Only)" in this chapter.
- 4. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.
- 5. Remove the hot-plug fans. Refer to "Hot-Plug Fans (Processor and I/O)" in this chapter.
- 6. Remove the fan basket. Refer to "Fan Basket" in this chapter.
- 7. Unscrew and move aside the processor fan bracket. It is not necessary to disconnect cables or remove this component completely for this procedure. Refer to "Processor Fan Bracket" in this chapter.
- 8. Disconnect the front panel LED assembly from the power backplane.



Figure 2-55: Removing the front panel LED assembly power cable

9. Disconnect the cable from all cable guide clips, and pass it through the cable guide opening toward the front of the server.

10. Press the tabs inward on both sides of the front panel LED assembly (1).

NOTE: Press the tabs with your fingers. Using a screwdriver may damage the tabs.

11. With the tabs released, pull the front panel LED assembly all the way out of the front of the bezel (2).



Figure 2-56: Removing the front panel LED assembly

Reverse steps 1 through 11 to replace the front panel LED and cable assembly.

Miscellaneous Mechanical Parts

Several mechanical components can be removed without powering down the server:

- Locking casters
- Power supply blank
- SCSI hard drive blank
- Removable media blank

Locking Casters

To remove the locking casters:

- 1. Prepare the server for a non-hot-plug procedure. Refer to "Preparing the Server for Non-Hot-Plug Procedures" in this chapter.
- 2. Place the server on its side, and remove the three Torx T-15 screws securing each caster to the chassis.
- 3. Pull the locking casters away from the server.



Figure 2-57: Removing the locking casters

Reverse steps 1 through 3 to replace the locking casters.

Power Supply Blank

CAUTION: Always populate power supply bays with either a power supply or blank. Proper airflow can only be maintained when the bays are populated. Unpopulated power supply bays can lead to improper cooling and thermal damage.

To remove a power supply blank:

- 1. Remove the two Torx T-15 screws securing the hot-plug power supply blank to the chassis (1).
- 2. Pull the power supply blank up and away from the chassis (2).



Figure 2-58: Removing the power supply blank

Reverse steps 1 and 2 to replace a power supply blank.

SCSI Hard Drive Blank

To remove a drive blank:

1. Open the front bezel door (tower model only). Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.

- 2. Push the sliding release button to unlock the blank (1).
- 3. Pull the drive blank out from the drive cage (2).



Figure 2-59: Removing the drive blank

Reverse steps 1 through 3 to replace a drive blank.

Removable Media Blank

To remove a removable media blank:

- 1. Remove the front bezel door (tower model only). Refer to "Removing the Front Bezel Door (Tower Model Only)" in this chapter.
- 2. Remove the access panel. Refer to "Removing the Access Panel" in this chapter.

- 3. Slide the blue locking lever on the outside of the removable media area to release the blank (1).
- 4. Pull the removable media blank from the removable media area (2).



Figure 2-60: Removing a removable media blank from the removable media area

Reverse steps 1 through 4 to install a removable media blank.

Cable Routing Diagrams

CAUTION: When routing cables, always make sure that the cables are not in a position in which they can be pinched or crimped.

System Board Power Cables



Figure 2-61: System board power cable routing

Drive Fan Power Cables



Figure 2-62: Drive fan power cable routing

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Diskette and CD-ROM Drive Cables

Figure 2-63: Diskette and CD-ROM drive cable routing

Table 2-10:	Diskette and	CD-ROM Drive	Cable	Routing
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Item	Description
1	Power cable for both diskette and CD-ROM drives
2	Data cable for CD-ROM drive
3	Data cable for diskette drive

SCSI Backplane Power Cables



Figure 2-64: SCSI backplane power cable routing

SCSI Cables



Figure 2-65: SCSI cable routing

1 SCSI A (blue)	
2 SCSI B (yellow)	



Figure 2-66: Internal-to-external SCSI cable routing

NOTE: The internal-to-external SCSI cable ships unconnected. If you want to connect it, you must disconnect one of the drive cages.

Table 2-12 lists the cables required for each optional hardware component.

Component	Required Cables	Cable ships with:
Drive cage A	Power	Server
	Signal	Server
Drive cage B	Power	Server
	Signal	Server
SCSI devices in the removable media bay	Power	Server
	Signal	Server
IDE devices in the removable media bay	Power	Server
	Signal	Option kit
DVD drive in the CD-ROM bay	Power	Server
	Signal	Option kit
Remote Insight lights-Out Edition II	Power	Option kit
	Signal	Option kit
Front panel LED assembly	Power	Server
External storage devices	Signal	Option kit or option cable kits
External SCSI	Signal	Server

Table 2-12: Required Cables

Re-entering the Server Serial Number

After replacing the system tray or clearing the NVRAM, the server serial number must be reentered. To re-enter the serial number:

- 1. During the server startup sequence, press the F9 key to access RBSU.
- 2. Select the **System Options** menu.
- 3. Select Serial Number. The following warning is displayed:

WARNING! WARNING! WARNING! The serial number is loaded into the system during the manufacturing process and should NOT be modified. This option should ONLY be used by qualified service personnel. This value should always match the serial number sticker located on the chassis.

Press the **Enter** key to clear the warning.

- 4. Enter the serial number and press the **Enter** key.
- 5. Press the **Escape** key to close the menu.
- 6. Press the **Escape** key to exit RBSU.
- 7. Press the F10 key to confirm exiting RBSU. The server will automatically reboot.

3 Diagnostic Tools

This chapter is an overview of software and firmware diagnostic tools that are available for configuring, monitoring, and managing HP ProLiant ML570 Generation 2 servers.

Use the following tools to diagnose problems, test hardware, and monitor and manage server operations.

Table 3-1: Diagnostic Tools

ТооІ	Description	How to run the tool
Array Diagnostics Utility (ADU)	ADU is designed to run on all HP systems that support HP array	For a list of HP servers that support ADU, visit www.hp.com.
	about the array controllers in the system and generates a list of detected problems.	For a complete list of ADU error messages, refer to the <i>HP Servers Troubleshooting Guide</i> .
Automatic Server Recovery-2 (ASR-2)	ASR-2 automatically restarts the server after a catastrophic operating system failure.	Run RBSU and set ASR-2 to enable this tool.
	With ASR-2, you have multiple recovery options:	
	 Available Recovery provides software error recovery and environmental recovery. 	
	 Unattended Recovery logs the error information to the IML, resets the server, and tries to restart the operating system. 	
Diagnostics Utility	Diagnostics Utility tests and verifies operation of HP hardware. If the utility finds a hardware failure, it isolates the replaceable part, if possible.	Access Diagnostics Utility when POST detects a system configuration error. For a complete list of POST error messages, refer to the <i>HP Servers Troubleshooting</i> <i>Guide.</i> Diagnostics Utility can be run from the SmartStart CD or downloaded from www.hp.com.
Insight Manager 7	Insight Manager 7 is a client/server application used to remotely manage HP hardware in a network environment. Insight Manager 7 reports hardware fault conditions (both failure and pre failure) and collects data for reporting and graphing.	For more information on viewing and printing the event list, refer to the Management CD, the <i>HP Insight</i> <i>Manager User Guide</i> or the <i>HP</i> <i>ProLiant ML570 Generation 2 Server</i> <i>Setup and Installation Guide.</i>

continued

ΤοοΙ	Description	How to run the tool
SmartStart	SmartStart software is the intelligent way to set up the HP server. The SmartStart CD includes the ROMPaq Utility, driver updates, and assistance installing operating systems.	Use the information provided in the Server Setup and Management pack.
Survey Utility	Survey Utility gathers critical hardware and software information on servers running Microsoft® Windows NT®, Novell NetWare, SCO OpenServer, or SCO Unixware operating systems.	Install the Survey Utility from the SmartStart CD, the Integration Maintenance Utility, or the Management CD.
	If a significant change occurs between data-gathering intervals, the Survey Utility marks the previous information and overwrites the survey text files to reflect the latest changes in the configuration.	
Integrated Management Log (IML)	The IML is a log of system events such as system failures or nonfatal error conditions. View events in the IML from within:	The IML requires operating system management drivers. Refer to the SmartStart CD for instructions on installing the appropriate drivers.
	Insight Manager 7	
	Survey Utility	
	Operating-system-specific IML utilities	
ROM-Based Setup Utility (RBSU)	RBSU configures the hardware installed in or connected to the server. Specifically, it can:	Run RBSU by pressing the F9 key during POST.
	Store configuration information in nonvolatile memory	
	 Manage memory installation, processor upgrades, network interface cards and mass storage devices 	
	Assist in installing an operating system	
	 Configure ports and IRQs, if required 	

 Table 3-1: Diagnostic Tools continued

continued

Tool	Description	How to run the tool
ROMPaq Utility	The ROMPaq Utility checks the system and provides a choice of available ROM revisions and controller firmware.	Run this utility from the SmartStart CD included with the server.
SmartStart Diskette Builder	The SmartStart Diskette Builder is a utility that uses data stored on the SmartStart CD to create support diskettes. You can create support diskettes for specific configuration needs or for software that cannot be used directly from the SmartStart CD.	Run the diskette builder tool from the SmartStart CD.

Table 3-1: Diagnostic Tools continued

4

Connectors, LEDs, and Switches

This chapter explains the location and function of system connectors, internal and external LEDs, and system board switches.

Connectors

The figures and tables in this chapter show connector locations on the system board, memory board, and rear panel of an HP ProLiant ML570 Generation 2 server.

System Board



Figure 4-1 and Table 4-1 identify the connectors on the system board of the server.

Figure 4-1: System board connectors

Table 4-1:	System	Board	Connectors
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Item	Connector
1	Secondary IDE (non-bootable)
2	Remote management (30-pin)
3	Remote management (16-pin)
4	I/O fans
5	System power
6	SCSI A (blue)
7	SCSI B (yellow)
8	Power backplane signal
9	Primary IDE (bootable) (orange)
10	Diskette drive (purple)
11	Processor fans
12	System power
13	PCI backplane

Memory Board



Figure 4-2 and Table 4-2 identify the slots on the memory boards of the server.

Figure 4-2: DIMM slots

Item	Slot	Bank
1	DIMM slot 1	Bank A
2	DIMM slot 2	Dank A
3	DIMM slot 3	- Bank B
4	DIMM slot 4	Dalik D
5	DIMM slot 5	Bank C
6	DIMM slot 6	Dank C
7	DIMM slot 7	Bank D *
8	DIMM slot 8	

* When the server is configured for online spare memory, Bank D on memory board 1 is the online spare bank.

Rear Panel



Figure 4-3 and Table 4-3 identify the connectors on the rear panel of the server.

Figure 4-3: Rear panel connectors

Table 4-3:	Rear	Panel	Connectors
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Item	Description	Item	Description
1	Keyboard connector	10	Hot-plug power supply 1
2	Mouse connector	11	Hot-plug power supply 2
3	Serial connector A	12	Torx T-15 tool
4	Parallel connector	13	Unit ID switch and LED
5	Embedded NIC connector (RJ-45)	14	USB connectors
6	Release latch	15	Video connector
7	VHDCI SCSI connector	16	Serial connector B
8	PCI-X Hot Plug expansion slots	17	Hot-plug power supply bay 3 (redundant)
9	PCI-X non-hot-plug expansion slots		

System LEDs

The server contains LEDs that indicate the status and settings of hardware components. This section discusses the following types and locations of LEDs:

- Front panel
- System board
- Memory board
- PCI-X Hot Plug
- Expansion slot speed
- Hot-plug power supply
- Hot-plug fan
- Embedded NIC connector (RJ-45) activity
- Rear Unit Identification (UID) LED
- Hot-plug hard drive

Information at the end of this section discusses the interactions between external and system board LEDs in troubleshooting or assessing system status.

Front Panel LEDs

The set of five LEDs on the front of the server indicate system health. Figure 4-4 and Table 4-4 identify and describe the location and function of each of the LEDs.



Figure 4-4: Front panel LEDs

Table 4-4: Front Panel LEDs

LED	Description	State
1	UID button and LED	Blue = Activated Blue flashing = System is being managed remotely Off = Deactivated
2	Internal health LED*	Green = Normal (system on) Amber = System health degraded Red = System has critical failure Off = System is off
3	External health (power supply) LED	Green = Normal (system on) Amber = Redundant power supply failure Red = Critical power supply failure Off = System is off
4	Embedded NIC activity LED	Green = Network link Blinking = Network link with activity Off = No network connection
5	Power On/Standby button and LED	Amber = System is off (auxiliary power present) Green = System is on Off = Server has no A/C power

*The internal health LED identifies service events for internal components in a prefailure or failed condition. For a list of these events, refer to the *HP ProLiant ML570 Generation 2 Server Setup and Installation Guide*.

System Board LEDs



Figure 4-5 and Table 4-5 identify system board LED locations and status indications.

Figure 4-5: System board LEDs

Table 4-5:	System	Board L	_EDs
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LED	Description	State
1	PPM 1	
2	Processor 1	Amber = Processor or PPM failed
3	PPM 2	Off = Normal
4	Processor 2	_
5 Thermal warning	Amber = Thermal event	
	mermar warning	Off = Normal
6	Memory board interlock	Amber = Memory boards interlock failed
0	LED	Off = Normal
7	Processor 3	
8	PPM 3	Amber = Processor or PPM failed
9	Processor 4	Off = Normal
10	PPM 4	_

Memory Board LEDs and Icons



Figure 4-6 and Table 4-6 identify LEDs on the memory board.

Figure 4-6: Memory board LEDs and icons

Item	Description	Indicator	Status
1 Memory		Off	Memory board is offline.
	Status	Green	Memory board is online.
		Flashing green	Memory board is busy.
		Amber	Memory error has occurred on this memory board.
8	DIMM 1-8	Off	DIMM is not installed.
	status	Green	DIMM is installed.
		Amber	Memory error has occurred on this DIMM.
		Flashing amber	Configuration error has occurred.
1-4, 7, 8	All LEDs	Flashing amber	Memory board is in use; relock it immediately.

Table 4-6: Advanced ECC (Standard) Memory LEDs

Item	Description	Indicator	Status
1	Memory	Off	Memory board is offline.
	Status	Green	Memory board is online.
		Flashing green	Memory board is busy.
		Amber	Memory error has occurred on this memory board.
2	Online Spare Status	Off	Memory board is not configured for online spare memory.
		Green	Online spare memory is functioning properly.
		Amber	Memory error has occurred and system has failed over to the online spare bank.
7 Online Spare		Off	Bank is not configured as an online spare bank.
	text	Green	Bank is configured as an online spare bank.
		Flashing green	Failure has occurred and online spare bank is active.
8	DIMM 1-8	Off	DIMM is not installed.
	status	Green	DIMM is installed.
		Amber	Memory error has occurred on this DIMM.
		Flashing amber	Configuration error has occurred.
1-4, 7, 8	All LEDs	Flashing amber	Memory board is in use; relock it immediately.

 Table 4-7: Online Spare Memory LEDs

Item	Description	Indicator	Status
1	Memory status	Off	Memory board is offline.
		Green	Memory board is online.
		Flashing green	Memory board is busy.
		Amber	Memory error has occurred on this memory board.
3	Mirroring status	Off	Memory board is not configured for mirrored memory.
		Green	Single-board mirrored memory is functioning properly.
		Amber	Memory error has occurred and system has failed over to the mirrored bank(s).
8	DIMM 1-8 status	Off	DIMM is not installed.
		Green	DIMM is installed.
		Amber	Memory error has occurred on this DIMM.
		Flashing amber	Configuration error has occurred.
1-4, 7, 8	All LEDs	Flashing amber	Memory board is in use; relock it immediately.

Table 4-8: Single-Board Mirrored Memory LEDs

Item	Description	Indicator	Status
1	Memory Status	Off	Memory board is offline.
		Green	Memory board is online.
		Flashing green	Memory board is busy.
		Amber	Memory error has occurred on this memory board.
3	Mirroring Status	Off	Memory board is not configured for mirrored memory.
		Green	Hot-plug mirrored memory is functioning properly.
		Amber	Memory error has occurred and system has failed over to the mirrored board.
4	Ready to Hot Plug	Off	Do not remove memory board—memory board is not ready for removal.
		Green	Okay to remove memory board.
8	DIMM 1-8	Off	DIMM is not installed.
	status	Green	DIMM is installed.
		Amber	Memory error has occurred on this DIMM.
		Flashing amber	Configuration error has occurred.
1-4, 7, 8	All LEDs	Flashing amber	Memory board is in use; relock it immediately.

Table 4-10: Memory Board Icons

Item	Description	Status
5	Lock	Memory board is locked and cannot be removed.
6	Unlock	Memory board is unlocked; do not remove unless the Ready to Hot Plug LED illuminates green.

Note: The icon at which the memory board switch is pointed indicates whether the memory board is locked or unlocked.

PCI-X Hot Plug LEDs

The PCI-X Hot Plug LEDs provide a visual status for each slot and are viewable from the rear or from inside the server after removing the access panel.



Figure 4-7 and Table 4-11 identify PCI-X Hot Plug LEDs.

Figure 4-7: Internal and External PCI-X Hot Plug LEDs

Table 4-11:	Internal	and External	PCI-X	Hot Plug	LEDs
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Item	Description
1	Power LED (green)
2	Fault LED (amber)
3	PCI-X Hot Plug button

Table 4-12 identifies PCI-X Hot Plug slot activity status according to LED description.

LED	State	OK to Open	Slot Status
Power	On	No	Power is currently applied to the slot. Do not open the
Fault	Off	INO	expansion slot latch. The slot is functioning normally.
Power	On	NI-	Power is currently applied to this slot, but the slot needs
Fault	On	NO	board, or driver. Do not open the expansion slot latch.
Power Fault	Flashing		The power slot is being turned off or on, which may take several minutes. Do not open the expansion slot latch. Press the PCI-X Hot Plug button to cancel the operation.
	On or Off	No	
Power	Off	N	Power to this slot is turned off, but this slot needs
Fault	On	Yes	attention. A problem may exist with the slot, expansion board, or driver.
Power	Off	Yes	The power to the slot is off. An expansion board may be
Fault	Off		installed in this slot.
Note: If a	ny of the LE	Ds indicates an	error refer to the HP ProLiant MI 570 Generation 2 Server

 Table 4-12: Internal and External PCI-X Expansion Slot LEDs

Note: If any of the LEDs indicates an error, refer to the *HP ProLiant ML570 Generation 2 Server*. *Setup and Installation Guide* for more information.

Expansion Slot Speed LEDs

The bus architecture delivers matched speed of expansion boards on the same bus.

IMPORTANT: Always pair expansion boards of the same speed on the same bus for optimal performance. If expansion boards of different speeds are installed on the same bus, the server sets the bus speed to the slower PCI board.

Figure 4-8 and Table 4-13 identify the speed for each PCI slot and to help ensure optimal performance.



Figure 4-8: Expansion slot speed LEDs

LED	Slot Speed
1	33-MHz PCI
2	66-MHz PCI
3	66-MHz PCI-X
4	100-MHz PCI-X
Hot-Plug Power Supply LEDs

Determine the hot-plug power supply status by noting the color of the power supply LED located adjacent to the AC power socket.



Figure 4-9: Power supply LEDs (rack configuration)

Table 4-14:	Power Supply LEDs
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Power Supply Condition	1 Power LED (Green)	2 Fault LED (Amber)
No AC power to any power supply	Off	Off
No AC power to a particular power supply	Off	On
AC power present; system in standby mode	Blinking	Off
Power supply on and working properly	On	Off
Power supply current limit exceeded	On	Blinking

Hot-Plug Fan LEDs



Each hot-plug fan has a corresponding status LED in the fan basket.

Fan	Description	Status
1	Standard processor fan	
2	Optional redundant processor fan	Green = The fan is operating
3	Standard I/O fan	normally.
4	Optional redundant I/O fan	Amber = The fan has failed.
5	Drive fan	Off = The fan is not installed, has no power, or is not
6	Drive fan	properly seated.
7	Drive fan	

NOTE: The hot-plug rear processor air baffle and fan assembly LED is not shown. It also indicates operational status as described in Table 4-15.

Embedded NIC Connector Activity LEDs

The RJ-45 connector for the embedded NIC, located on the rear panel, contains two LEDs. Figure 4-11 and Table 4-16 identify the LED locations and status.



Figure 4-11: Embedded NIC connector activity LEDs

LED	Description	State
1	Activity	On or flashing = Network activity
		Off = No network activity
0	Link	On = Linked to network
2		Off = No network link

Table 4-16: Embedded NIC Connector Activity LEDs

Rear Unit Identification LED and Button

The server includes unit identification (UID) LEDs with buttons on both the front and rear panels. The UID LEDs indicate activity status and can be toggled on and off by pushing the UID button or through Insight Manager 7.

The rear UID provides a visual reference for locating an individual server in a rack of servers. The rear UID contains an integrated button to activate or deactivate the LED.



Figure 4-12: Rear UID and button (tower model)

The rear UID indicates the following states:

- Blue = The button is activated.
- Blue flashing = The system is being monitored remotely.
- Off = The button is deactivated.

NOTE: You can activate and deactivate the UID from either the front or rear UID button.

Hot-Plug Hard Drive LEDs

Each hot-plug hard drive has three LEDs located on the front of the drive. They provide activity, online, and fault status for each corresponding drive when configured as part of an array and attached to an active Smart Array Controller. LED behaviors may vary, depending on the status of other drives in the array. Figure 4-13 and Tables 4-17 and 4-18 identify LED locations and analyze the status of each hot-plug hard drive.

CAUTION: Read the *HP Servers Troubleshooting Guide* before removing a hard drive.



Figure 4-13: Hot-plug hard drive LEDs

	LED	Description	State
1	Drive activity	On = Drive activity	
		Off = No drive activity	
2	Online status	Flashing = Online activity	
		Off = No online activity	
3	Fault status	Flashing = Fault-process activity	
		Off = No fault-process activity	

Activity LED	Online LED	Fault LED	Status	
On	Off	Off	Do not remove the drive. Removing a drive during this process causes data loss.	
			The drive is being accessed and is not configured as part of an array.	
On	Flashing	Off	Do not remove the drive. Removing a drive during this process causes data loss.	
			The drive is rebuilding or undergoing capacity expansion.	
	Flashing	Flashing	Do not remove the drive. Removing a drive during this process causes data loss.	
Flashing			The drive is part of an array being selected by the Array Configuration Utility.	
			-Or-	
			The Options ROMPaq is upgrading the drive.	
	Off		OK to replace the drive online if a predictive failure alert is received and the drive is attached to an array controller.	
			The drive is not configured as part of an array.	
0#		Off	-Or-	
Oli		Uir	If this drive is part of an array, a powered-on controller is not accessing the drive.	
			-Or-	
			The drive is configured as an online spare.	
Off	Off	On	OK to replace the drive online.	
			The drive has failed and has been placed offline.	
Off	On	Off	OK to replace the drive online if a predictive failure alert is received (refer to "System LEDs and Internal Health LED Status Combinations" for details), provided that the array is configured for fault tolerance and all other drives in the array are online.	
			The drive is online and configured as part of an array.	
On or flashing	On	Off	OK to replace the drive online if a predictive failure alert is received (refer to "System LEDs and Internal Health LED Status Combinations" for details), provided that the array is configured for fault tolerance and all other drives in the array are online.	
			The drive is online and being accessed.	

Table 4-18: Hot-Plug Hard Drive LED Combinations

System LEDs and Internal Health LED Status Combinations

When the internal health LED on the front panel illuminates either amber or red, the server is experiencing a health event. The combinations of illuminated system LEDs and the internal health LED in Table 4-19 indicate system status.

NOTE: The system management driver must be installed in order for the internal health LED to provide pre-failure warranty conditions.

The internal health LEDs on the front panel indicate the current hardware status and are used to assist in initial troubleshooting. Note that in some situations, Insight Manager 7 reports server status differently than the health LEDs because it tracks more system attributes.

Table 4-19: System LEDs and Internal Health LED Status Combinations

System LED and Color	Internal Health LED Color	Status	
		Processor has failed.	
Processor failure (ambar)	Red	Required processor is not installed in socket.	
Frocessor failure (arriber)		ROM detects a failed processor during POST.	
	Amber	Processor is in pre-failure condition.	
		PPM has failed.	
PPM failure (amber)	Red	 PPM is not installed, but the corresponding processor is installed. 	
DIMM failure (amber)	Red	DIMM has experienced a multi-bit error.	
	Amber	DIMM has reached single-bit correctable error threshold.	
DIMM failure, all slots in one bank (amber)	Red	Interleaving error: The bank is not populated entirely, or DIMMs do not all match within the bank.	
DIMM failure, all slots (amber)	Red	No valid or usable memory is installed in the system.	
Thermal warning (amber)	Red	System has exceeded operating system cautionary level or critical hardware level.	
5 ()	Green	Normal	
Fan (amber)	Red	A required fan has failed or is missing.	
	Amber	A redundant fan has failed.	
Bower supply (off)	Red	A required power supply has failed.	
rower supply (oii)	Amber	A redundant power supply has failed.	

System Board Switches

Some server operations, including adding or removing a component, changing a security feature, or reconfiguring the server from tower to rack, require that you reconfigure a system switch. If the system configuration is incorrect, the server may not work properly and you may receive error messages on the screen.

This section discusses the following system board switches:

- System maintenance
- Non-maskable interrupt (NMI)



Figure 4-14: System board switches

Table 4-20:	System	Board	Switches
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Switch	Switch Type
1	System maintenance switch (SW4)
2	NMI switch (SW3)

System Maintenance Switch



The system maintenance switch (SW4) is an eight-position switch that is used for system configuration. The default setting for all six positions is off.

Figure 4-15: System maintenance switch (SW4)

Table 4-21: S	ystem	Maintenance	Switch	(SW4)	1
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Position	Description	On/Off Function
1	Reserved	
0	Lock configuration	Off = System configuration can be changed.
2	information	On = System configuration is locked and cannot be changed.
0	Towar/rook model coloct	Off = System is in a tower configuration.
3	Tower/fack model select	On = System is in a rack configuration.
4 Enable diskette boot	Enable diskette boot	Off = Booting from diskette is controlled by RBSU.
	Enable diskelle bool	On = Booting from diskette is enabled and RBSU setting is overridden.
F	Clear aveter passwords	Off = System passwords work normally.
5 Clear system passwords		On = System passwords will be erased.
6	Invalidate non-volatile RAM	Off = No function is available.
0	(NVRAM) and CMOS	On = ROM treats system configuration as invalid.
7	Reserved	
8	Reserved	

Note: To access redundant ROM, set system maintenance switches 1, 5, and 6 to the "on" position. Refer to the *HP ProLiant ML570 Generation 2 Server Setup and Installation Guide* for more information.

Note: The server serial number must be re-entered through RBSU after clearing the NVRAM. Refer to "Re-entering the Server Serial Number" in Chapter 2.

Non-Maskable Interrupt Switch

Crash dump analysis is an essential part of eliminating reliability problems such as hangs or crashes in operating systems, device drivers, and applications. Many crashes freeze a system requiring you to do a hard reset. Resetting the system erases any information that supports root cause analysis.

When an operating system crashes, system administrators can perform a non-maskable interrupt (NMI) event by pressing a dump switch. The NMI event enables a hung system to once again become responsive.

The NMI switch is used ONLY in the event of a service emergency that requires a complete data dump in preparation for recovering the system from a catastrophic event.

System Configuration Settings

It may be necessary at some time to clear and reset system configuration settings. When the system maintenance switch position 6 is set to the On position, the system is prepared to erase all system configuration settings from both CMOS and NVRAM. For additional information about locating the switch and switch settings, refer to "System Maintenance Switch" in this chapter. The default setting for all positions is off.

IMPORTANT: Clearing CMOS and/or NVRAM deletes your configuration information. Refer to the *HP ProLiant ML570 Generation 2 Server Setup and Installation Guide* for complete instructions on configuring the server.

IMPORTANT: The server serial number must be re-entered through RBSU after clearing the NVRAM. Refer to "Re-entering the Server Serial Number" in Chapter 2.

To erase all system configuration settings:

- 1. Power down the server.
- 2. Remove the access panel.
- 3. Set the position 6 lever to the On position.
- 4. Power up the server, and wait for the system to display a message confirming that the maintenance switch has been set.
- 5. Power down the server.
- 6. Reset the position 6 lever to the default Off position.
- 7. Power up the server.
- 8. Press the **F9** key to run RBSU and reset all system configuration settings.

For instructions on using RBSU to reset system configuration settings, refer to the *HP ProLiant ML570 Generation 2 Server Setup and Installation Guide*.

Troubleshooting

This chapter provides specific troubleshooting information for the HP ProLiant ML570 Generation 2 server. Use it to find details about server startup and operation errors.

For a list of new server error messages specific to this server, refer to the *HP ProLiant ML570 Generation 2 Server Setup and Installation Guide*. For information on LEDs and switches specific to the server, refer to Chapter 4, "Connectors, LEDs, and Switches."

For a more detailed discussion of troubleshooting techniques, diagnostic tools, error messages, and preventative maintenance, refer to the *HP Servers Troubleshooting Guide* included on the Documentation CD that ships with the server.



WARNING: A risk of personal injury exists from hazardous energy levels. The installation of options and the routine maintenance and service of this product shall be performed by individuals who are knowledgeable about the procedures, precautions, and hazards associated with equipment containing hazardous energy circuits.

For troubleshooting information beyond the scope of this guide, both general and specific to HP ProLiant ML570 Generation 2 servers, refer to Table 5-8.

When the Server Does Not Start

This section provides systematic instructions on what to try and where to go for help for the most common problems encountered during initial POST. The server must complete this test each time you power up before it can load the operating system and start running software applications.



WARNING: A risk of personal injury exists from hazardous energy levels. The installation of options, and the routine maintenance and service of this product shall be performed by individuals who are knowledgeable about the procedures, precautions, and hazards associated with equipment containing hazardous energy circuits.

If the server does not start:

- 1. Be sure that the server and monitor are plugged into a working outlet.
- 2. Be sure that the power source is working properly:
 - a. Check the status using the system power LED.
 - b. Be sure that the Power On/Standby button was pressed firmly.

3. Be sure that the power supplies are working properly by checking the power supply LEDs.

NOTE For information on LEDs and switches specific to the server, refer to Chapter 4, "Connectors, LEDs, and Switches." For more information about power, refer to the *HP Servers Troubleshooting Guide*.

- 4. If the system does not complete POST or start loading an operating system, refer to the *HP Servers Troubleshooting Guide*.
- 5. If the server is rebooting repeatedly, verify that the system is not rebooting due to a problem that initiates an ASR-2 reboot.

Some operating systems reboot the server when an error occurs. This is the default in the Windows® 2000 operating system.

6. Restart the server.

IMPORTANT: If the server does not restart, proceed to "Diagnostic Steps."

- 7. Check the server for the following normal power-up sequence to be sure that the system meets the minimal hardware requirements and is powered up during normal operations:
 - a. The power button LED turns from standby (amber) to on (green).
 - b. The fans start up.
- 8. Check the monitor for the following messages that verify the system meets the minimal hardware requirements and is powered up during normal operations:
 - a. HP ProLiant logo
 - b. BIOS information
 - c. Copyright information
 - d. Processor initialization
 - e. Multi-initiator configuration

IMPORTANT: Select the multi-initiator configuration utility (CTRL-A) only to support HP storage and clustering options. Refer to the *HP ProLiant ML570 Generation 2 Server Setup and Installation Guide.*

- f. PXE initialization
- g. Option ROMs
- h. SCSI devices
- 9. The operating system loads to complete the boot process.

If the server completes POST and attempts to load the operating system, go to the "Problems After Initial Boot" section in this chapter.

Diagnostic Steps

If the server does not power up, or powers up but does not complete POST, answer the questions in Table 5-1 to determine appropriate actions based on the symptoms observed. The flow of questions reflects the usual flow of events during a power-on sequence.

According to the answers you give, you will be directed to an appropriate secondary table in this section. The table outlines possible reasons for the problem, options available to assist in diagnosis, possible solutions, and references to other sources of information.

Question	Action
Question 1:	If no, continue to question 2.
Is the system power button LED off?	If yes, refer to Table 5-2.
Question 2:	If yes, continue to question 3.
Is the system power button LED illuminated green?	If no, refer to Table 5-3.
Question 3:	If yes, continue to question 4.
Is the external health LED illuminated green?	If no, refer to Table 5-4.
Question 4:	If yes, continue to question 5.
Is the internal health LED illuminated green?	If no, refer to Table 5-5.
Question 5:	If yes, use the POST messages for further
Is the monitor displaying information?	diagnosis. Refer to Table 5-6 for details.
	If no, refer to Table 5-6.

Table 5-1: Diagnostic Steps

Answer	Possible Reasons	Possible Solutions		
Yes, it is off	The system is not connected to AC power, or no AC power is available.	Be sure that the power cord is connected to the power supply. Check the power distribution unit, UPS, or AC circuit.		
	A power supply problem exists. The power supply may not be connected or inserted properly, it may have a damaged connector, or it may have failed.	Be sure that the power supply is undamaged, the power supply is fully seated, and the power supply LED is illuminated green when you power up the server.		
	A broken connection exists between the front panel LED assembly and the power backplane.	Be sure that the system power and power supply signal cables are connected to the system board and power backplane.		
	The front panel LED assembly has failed.	Be sure that the front panel LED assembly cable is connected to the power backplane.		
		Refer to the <i>HP Servers</i> <i>Troubleshooting Guide</i> for further options.		
No	If the system power button LED is illuminated amber, do the			
	1. Press the Power On/Standby bu	1. Press the Power On/Standby button.		
	2. Refer to Table 5-3.			

Answer	Possible Reasons	Possible Solutions	
No, it is off	Power On/Standby button has not been pressed firmly.	Firmly press the power button.	
	A power supply problem exists. The power supply may not be connected or inserted properly, it may have a damaged connector, or it may have failed.	Be sure that the power supply is undamaged, the power supply is fully seated, and the power supply LED is green.	
	The system may have experienced a short.	Check for bent connector pins and improperly seated expansion boards.	
	The front panel LED assembly has failed.	Be sure that the front panel LED assembly cable is connected to the power backplane.	
Yes	If the system power button LED is illuminated green, refer to Table 5-4.		

Table 5-3:	Is the Sys	tem Power	LED	Green?
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Note: For LED locations and functions, refer to Chapter 4, "Connectors, LEDs, and Switches." For cabling configurations, refer to the *HP ProLiant ML570 Generation 2 Server Setup and Installation Guide*.

Table 5-4: Is the External Health L	_ED Green?
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Answer	Possible Reasons	Possible Solutions	
No, it is amber	One power supply has failed; power supply redundancy is lost.	Be sure that each installed power supply is securely connected to an AC power source.	
		Locate the amber power supply LED to Identify the failed power supply.	
No, it is red	All installed power supplies have experienced a failure.	Remove all AC power from power supplies and reconnect to clear the error condition.	
		Replace the power supply.	
Yes	If the external health LED is illuminated green, refer to Table 5-5.		
Note: For LED locations and functions, refer to Chapter 4, "Connectors, LEDs, and Switches." For cabling configurations, refer to the <i>HP ProLiant ML570 Generation 2 Server Setup and Installation Guide.</i>			

Answer	Possible Reasons	Possible Solutions	
No, it is amber	A processor is in prefailure condition.	Use internal component	
	A DIMM is in prefailure condition.	failure LEDs to identify:	
	One memory bank is valid, but another	 Missing components 	
	bank is missing a DIMM.	Degraded components	
	One memory bank is valid, but another bank has mismatched DIMMs installed.	Failed components	
	One memory bank is valid, but another bank has an unsupported DIMM type installed.	 Improperty installed components 	
	A redundant fan has failed.		
No, it is red	A processor has failed.	Use internal component	
	Processor 1 is not installed.	failure LEDs to identify:	
	A processor is an unsupported type.	Missing components	
	Processor voltage requirements are	Failed components	
	mismatched.	Improperly installed	
	Processor does not have an associated PPM installed.	Components Thermal event	
	A PPM has failed.		
	A DIMM has experienced a multi-bit error.		
	DIMM pairs have mismatched DIMMs.		
	DIMMs are missing.		
	DIMMs are an unsupported type.		
	A required fan has failed.		
	A thermal event has occurred.		
	A component is not properly seated.	Be sure that all components	
	Memory board is missing.	are seated securely.	
		Add memory board.	
Yes	If the internal health LED is illuminated green, refer to Table $5-6$.		

Table 5-5: Is the Internal Health LED Green?

Answer	Possible Reasons	Possible Solutions	
No	The monitor may not have power.	Be sure that the monitor AC power cord is plugged in and that the monitor power button has been pressed.	
	Video may not be connected properly.	If a video card is installed, be sure that the video cable is properly connected.	
		If a Remote Insight Lights-Out Edition expansion board is installed, verify that the video cable is connected to the video connector on this expansion board.	
		Verify the video connections. Refer to the <i>HP Servers Troubleshooting Guide</i> .	
	Non-volatile RAM (NVRAM) may be corrupted.	Clear NVRAM. Refer to the following Caution. Refer to Chapter 4, "Connectors, LEDs, and Switches," for the correct switch setting.	
		Are there any audible indicators, such as a series of beeps? A series of beeps is the audible signal indicating the presence of a POST error message. Refer to the <i>HP Servers Troubleshooting Guide</i> for a complete description of each beep sequence and the corresponding error messages.	
	The system ROM and redundant ROM may be corrupted.	If the system ROM and redundant ROM are corrupt, refer to "ROMPaq Disaster Recovery" in this chapter for instructions on performing a recovery procedure.	
Yes	Video is available for diagnosis. Determine the next action by observing POST progress and error messages. Refer to the <i>HP Servers Troubleshooting Guide</i> for a complete description of each POST error message.		
•			
	CAUTION: Clearing NVRAM deletes the configuration information.		

Table 5-6: Is the Monitor Displaying Information?

Problems After Initial Boot

Once the server has passed POST, you may still encounter errors, such as an inability to load the operating system. Use the Table 5-7 to troubleshoot server installation problems that occur after the initial boot.

Refer to the *HP Servers Troubleshooting Guide* for more information.

Problem	Possible Reasons	Possible Solutions
System cannot load SmartStart.	SmartStart requirement not performed.	Check the SmartStart Release Notes provided in the SmartStart Online Reference Information on the SmartStart CD.
	IDE cable or power cable not connected to CD-ROM drive.	Check the IDE signal cable between the system board and CD-ROM to ensure proper connection.
		Check the power supply connection between the CD-ROM drive and the power backplane.
	Insufficient memory is available.	A rare "insufficient memory" message may display the first time SmartStart is booted on certain unconfigured systems. Cold-boot the machine with the SmartStart CD inserted in the CD- ROM drive to correct the problem.
	Existing software is causing conflict.	Run the HP System Erase Utility. Read the Caution at the end of this table. Refer to the instructions in the <i>HP Servers Troubleshooting Guide</i> .

Table 5-7: Problems After Initial Boot

continued

Problem	Possible Reasons	Possible Solutions	
SmartStart fails during installation.	Error occurs during installation.	Follow the error information provided. If it is necessary to reinstall, run the HP System Erase Utility. Read the Caution at the end of this table. Refer to the instructions in the <i>HP Servers</i> <i>Troubleshooting Guide</i> .	
	CMOS is not cleared.	Run the HP System Erase Utility. Read the Caution at the end of this table. Refer to the instructions in the <i>HP Servers Troubleshooting Guide</i> .	
Server cannot load operating system.	Required operating system	Follow these steps:	
	step was missed.	 Note at which phase the operating system failed. 	
		2. Remove any loaded operating system.	
		 Refer to the operating system documentation. 	
		 Install the operating system again. 	
	Installation problem occurred.	Refer to the operating system documentation and to the SmartStart Release Notes on the SmartStart CD.	
		Run RBSU and check the OS Selection menu.	
	Problem was encountered with the hardware you have	Refer to the documentation provided with the hardware.	
	added to the system.	Refer to the <i>HP ProLiant ML570</i> <i>Generation 2 Server Setup and</i> <i>Installation Guide</i> to identify correct SCSI bus cabling configuration for the unit.	
	Problem was encountered with hardware added to a new configure-to-order system (where available).	You must complete the factory-installed OS software installation before adding new hardware to the system.	
		Be sure you are following the instructions provided in the Factory-Installed Operating System Software Installation Guide.	
		Remove the new hardware and complete the software installation. Then, reinstall the new hardware.	

ued
1



CAUTION: The HP System Erase Utility causes loss of all configuration information, as well as loss of existing data on all connected hard drives. Please read the appropriate section and the associated warning in the *HP Servers Troubleshooting Guide* before performing this operation.

Refer to the HP Servers Troubleshooting Guide for the following:

- Information you need to collect when diagnosing software problems and to provide when contacting support
- Instructions on how to upgrade the operating system and its drivers
- Information about available recovery options and advice on minimizing downtime

ROMPaq Disaster Recovery

A corrupted system ROM requires that you recreate the ROM BIOS by a process called disaster recovery. This operation can be accomplished only when the system is in disaster recovery (emergency repair boot) mode. When both system ROMs are corrupt, the system defaults into disaster recovery mode automatically and the server emits two extended beeps.

IMPORTANT: Before performing this operation, refer to the *HP Servers Troubleshooting Guide* for complete instructions on disaster recovery.

To perform ROMPaq disaster recovery:

- 1. Power down the server.
- 2. Set system maintenance switches 1, 4, 5, and 6 to the "on" position. For the location of these switches, refer to Chapter 4, "Connectors, LEDs, and Switches."
- 3. Power up the server. After the system powers on, it repeatedly emits two long beeps.
- 4. Power down the server again. If necessary, perform a forced shutdown by pressing the power button for 4 seconds.
- 5. Set system maintenance switches 1, 4, 5, and 6 back to the default position (off).
- 6. Power up the system.
- 7. Insert a ROMPaq diskette with the latest system ROM that you have downloaded from www.hp.com

IMPORTANT: The ROMPaq will flash both sides of the redundant ROM. This process may take up to 10 minutes.

- 8. Wait until the server emits three rising beeps, indicating the completion of the ROM flash process.
- 9. Restart the server.

Other Information Resources

Refer to the following additional information for help.

Table 5-8: Troubleshooting Resources

Resource	Description
HP Servers Troubleshooting Guide	This is a resource for obtaining troubleshooting information that is beyond the scope of this document. It includes general hardware and software troubleshooting information for all HP ProLiant servers, a complete list of error messages along with explanations of probable causes, and a list of remedial measures. This guide resides on the Documentation CD that ships with the server. To be sure that you have the most up-to-date copy of the <i>HP Servers Troubleshooting</i> <i>Guide</i> document, visit www.hp.com.
Other online documentation	Product Bulletin Quickspecs
	OS Support Matrix

For additional information on warranties and service and support upgrades (CarePaq services), visit www.hp.com.

Server Specifications

This chapter provides operating and performance specifications for the HP ProLiant ML570 Generation 2 server.

Feature	Units		
Dimensions	Rack (without front bezel, with power supply)	Tower (with front bezel, casters, power supply)	
Height	32.5 cm (12.8 in)	50.8 cm (20.0 in)	
Depth	65.0 cm (25.6 in)	70.6 cm (27.8 in)	
Width	44.4 cm (17.5 in)	32.5 cm (12.8 in)	
Weight	49.4 kg (109 lb) to 72.5 kg (160	lb)	
Input requirements			
Rated input voltage	100 to 127 VAC 200 to 240 VAC		
Rated input frequency	47 to 63 Hz		
Rated input current	11.2 A for 100 to 127 VAC 5.2 A for 200 to 240 VAC		
Rated input power	1099 W for 100 to 127 VAC 1066 W for 200 to 240 VAC		
BTUs per hour	3478 BTU/hr 100 to 127 VAC 3637 BTU/hr 200 to 240 VAC		
Power supply output (each power supply)			
Rated steady-state power	600 W		
Maximum peak power	600 W		
Temperature range			
Operating	10° to 35°C (50° to 95°F)		
Shipping	-30° to 60°C (-20° to 140°F)		
Relative humidity (non-condensing)			
Operating and Non-operating	20% to 80% and 5% to 90%		
Wet-bulb temperature	38.7°C (101.7°F)		
Heat dissipation	2400 BTU/hr maximum		

Table 6-1: System Unit Specifications

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